

SCHOOL OF ELECTRONICS ENGINEERING

M. Tech Internet of Things & Sensor Systems

Curriculum (2021-2022 admitted students)

VISION STATEMENT OF VELLORE INSTITUTE OF TECHNOLOGY

Transforming life through excellence in education and research.

MISSION STATEMENT OF VELLORE INSTITUTE OF TECHNOLOGY

World class Education: Excellence in education, grounded in ethics and critical thinking, for improvement of life.

Cutting edge Research: An innovation ecosystem to extend knowledge and solve critical problems.

Impactful People: Happy, accountable, caring and effective workforce and students.

Rewarding Co-creations: Active collaboration with national & international, industries & universities for productivity and economic development.

Service to Society: Service to the region and world through knowledge and compassion.

VISION STATEMENT OF THE SCHOOL OF ELECTRONICS ENGINEERING

To be a leader by imparting in-depth knowledge in Electronics Engineering, nurturing engineers, technologists and researchers of highest competence, who would engage in sustainable development to cater the global needs of industry and society.

MISSION STATEMENT OF THE SCHOOL OF ELECTRONICS ENGINEERING

- Create and maintain an environment to excel in teaching, learning and applied research in the fields of electronics, communication engineering and allied disciplines which pioneer for sustainable growth.
- Equip our students with necessary knowledge and skills which enable them to be lifelong learners to solve practical problems and to improve the quality of human life.

PROGRAMME EDUCATIONAL OBJECTIVES (PEOs)

- 1. Graduates will be engineering practitioners and leaders, who would help solve industry's technological problems
- 2. Graduates will be engineering professionals, innovators or entrepreneurs engaged in technology development, technology deployment, or engineering system implementation in industry
- 3. Graduates will function in their profession with social awareness and responsibility
- 4. Graduates will interact with their peers in other disciplines in industry and society and contribute to the economic growth of the country
- 5. Graduates will be successful in pursuing higher studies in engineering or management
- 6. Graduates will pursue career paths in teaching or research

PROGRAMME OUTCOMES (POs)

PO_01 : Having an ability to apply mathematics and science in engineering applications.

PO_02 : Having an ability to design a component or a product applying all the relevant standards and with realistic constraints, including public health, safety, culture, society and environment

PO_03 : Having an ability to design and conduct experiments, as well as to analyse and interpret data, and synthesis of information

PO_04 : Having an ability to use techniques, skills, resources and modern engineering and IT tools necessary for engineering practice

PO_05 : Having problem solving ability- to assess social issues (societal, health, safety, legal and cultural) and engineering problems

PO_06: Having adaptive thinking and adaptability in relation to environmental context and sustainable development

PO_07: Having a clear understanding of professional and ethical responsibility

PO_08: Having a good cognitive load management skills related to project management and finance

PROGRAMME SPECIFIC OUTCOMES (PSOs)

On completion of M. Tech. (Internet of Things & Sensor Systems) programme, graduates will be able to

- PSO1: Competent, and innovative with a strong cognizance in the area of sensors, IoT, data science, controllers and signal processing through the application of acquired knowledge and skills
- PSO2: Apply advanced techniques and tools of sensing and computation to solve multi-disciplinary challenges in industry and society.
- PSO3: To exhibit independent and collaborative research with strategic planning, while demonstrating the professional and ethical responsibilities of the engineering profession.

CREDIT STRUCTURE

Category-wise Credit distribution

Category	Credits
University core (UC)	27
Programme core (PC)	21
Programme elective (PE)	16
University elective (UE)	06
Total credits	70

DETAILED CURRICULUM

University Core - 27

S. No	Course Code	Course Title	L	Т	Р	J	C
1	MAT6001	Advanced Statistical Methods	2	0	2	0	3
2	ENG5001	Fundamentals of Communication Skills	0	0	2	0	2
	ENG5001 and	Technical English I and	{0	0	2	0	
3	ENG5002 or	Technical English II (or)	0	0	2	0}	2
	GER5001	Deutsch fuer Anfaeger	2	0	0	0	
4	STS5001 &	Soft Skills	0	0	0	0	2
4	STS5002						
5	SET5001	SET Project-I	0	0	0	0	2
6	SET5002	SET Project-II	0	0	0	0	2
7	ECE6099	Master's Thesis	0	0	0	0	16

Programme Core - 21

S. No	Course Code	Course Title	L	Т	Р	J	С
1	ECE5060	Principles of Sensors and Signal Conditioning	2	0	2	0	3
2	ECE5061	IoT Fundamentals and Architecture	3	0	0	0	3
3	ECE5062	Data Acquisition	0	0	4	0	2
4	ECE5063	Control Systems	0	0	4	0	2
5	ECE5064	Programming and scripting languages	0	0	4	0	2
6	ECE5065	Microcontrollers for IoT Prototyping	2	0	2	0	3
7	ECE6001	Wireless Sensor Networks and IoT	2	0	0	4	3
8	ECE6030	Signal Processing and Data Analytics	2	0	2	0	3

Programme Electives - 16

S.No	Course Code	Course Title	L	Т	Р	J	С
1	ECE5006	Flexible and Wearable Sensors	3	0	0	0	3
2	ECE5008	Micro and Nano Fluidics	2	0	0	4	3
3	ECE5066	Chemical and Environmental Sensor	2	0	2	0	3
4	ECE5067	Cloud and Fog Computing	2	0	2	0	3
5	ECE5068	IoT Security and Trust	2	0	0	4	3
6	ECE5069	IoT Applications and Web development	2	0	0	4	3
7	ECE6003	Micro Systems & Hybrid Technology	2	0	2	0	3
8	ECE6004	RF and Microwave Sensors	3	0	0	0	3
9	ECE6007	Biomedical sensors	2	0	2	0	3
10	ECE6087	Multi-disciplinary Product Development	3	0	0	4	4
11	ECE6088	Deep Learning — An Approach to Artificial Intelligence	3	0	0	0	3
12	ECE6089	Automotive Sensors & in-Vehicle Networking	2	0	2	0	3
13	ECE6090	Fibre optic Sensors and Photonics	3	0	0	0	3

Course Code	Course Title	L	Τ	P	J	С
ECE5060	PRINCIPLES OF SENSORS AND SIGNAL CONDITIONING	2	0	2	0	3
Pre-requisite	Nil	Sy	llab	us v	versi	ion
				1.0		
Course Objectiv	es:					
a compre characteri 2. To introdu and provid instrumen 3. To give a sensor tra 4. To impart	e in depth knowledge in physical principles applied in sensing hensive understanding on how measurement systems are do sed, and analysed. Lice the students to sources and detectors of various Optical ser de in-depth understanding of the principle of measurement, and ts and sensors for measuring velocity and acceleration fundamental knowledge on the basic laws and phenomena on nsformation of energy is based. a reasonable level of competence in the design, construction, al measurements strain, force, torque and pressure	esign nsing d the whic	ed, g me cory ch og	cali char of pera	brat nism tion	ed, is of
Expected Outco	mes:					
quantity2.Choose and sensitive 13.Design and 14.Evaluate 15.Locate difference6.Create and 27.Compete quantitiesModule:1Sensor ClassificaModule:2Opt	epts in common methods for converting a physical parameterin appropriate sensor comparing different standards and guidelmeasurements of physical parameters like pressure, flow, accelid develop sensors using optical methods with desired propertionperformance characteristics of different types of sensorsfferent types of sensors used in real life applications and parasealytical design and development solutions for sensors.in the design, construction, and execution of systems for nsor fundamentals and characteristicstion, Performance and Types, Error Analysis characteristicsical Sources and DetectorsOptical properties of semiconductor as sensors, LED, Semiconductor	lines lerati es uphra meas	to 1 ion, se ti urin	nako etc. heir	e hysi	cal
	sors, Thermal detectors, Photo multipliers, photoconductive					
	he photodiodes, CCDs.		u	<i>,</i> ,	1 110	.0
	nsity Polarization and Interferometric 4 hours					
Perot and Sagna	, Microbending concept, Interferometers, Mach Zehnder, M c, Phase sensor: Phase detection, Polarization maintaining fibe		elso	n, F	abry	/-
	in, Force, Torque and Pressure sensors 5 hours					
Piezo-resistive a	ain gage beam force sensor, piezoelectric force sensor, load of and capacitive pressure sensor, optoelectronic pressure sensors I conditioning circuits for strain gauges, piezo, capacitance a	s, va	cuu	m se	nso	rs.
Module:5 Posi sens	tion, Direction, Displacement and Level 4 hours					
	ad capacitive sensors, Inductive and magnetic sensor, LV	DT.	RV	DT.	ed	dv

current, trar	nsverse indu	ctive, Hall effect, magneto resist	ive, magnetostrictiv	e sensors	Fiber optic
		abry Perot sensor, ultrasonic sens			
1	0,	active and self generating sensors	· 1 1		8
		and Acceleration sensors	3 hours		
	-	ty sensor, Doppler with sound, I	light, Acceleromete	er charact	eristics,
		ive, piezoelectric accelerometer,			
and optical	gyroscopes.	-			
Module:7	Flow, Ten	nperature and Acoustic sensors	6 hours		
Flow senso	ors: pressure	e gradient technique, thermal tra	insport, ultrasonic,	electrom	agnetic and
		croflow sensor, coriolis mass fl	•		-
		ve, thermoelectric, semiconductor			
		s- microphones-resistive, capaciti	ve, piezoelectric, fi	ber optic,	, solid state -
electrect mi		_		1	
Module:8	_	orary Issues	2 hours		
	Total Lec	ture:	30 hours		
Text Book(s)		I		
		nd Book of Modern Sensors: phys	ics Designs and A	plication	s" 2015 3 rd
	, Springer, I		ies, Designs and rij	prication	, 2010, 5
		ensor Technology Hand Book", 20	011, 1 st edition. Else	vier. Net	herland.
Reference			,,,,,,	,	
1. GerdK	eiser,"Optic	al Fiber Communications", 2017,	5 th edition, McGrav	v-Hill Sci	ence, Delhi.
2. John G	Webster. '	'Measurement, Instrumentation a	nd sensor Handboo	k". 2017.	2^{nd} edition.
	ress, Florida))	,
3. Eric Ud	dd and W.	B. Spillman, "Fiber optic senso	rs: An introduction	n for eng	gineers and
		nd edition, Wiley, New Jersey.		· · · ·	
		and Malvin Carl Teich, "Funda	mentals of photonic	cs", 2012	, 1 st edition,
	Viley, New Y		-		
Mode of Ev	valuation:CA	AT, Digital Assignments, Quiz, O	nline course, Paper	publicati	on, Projects,
Hackathon/	Makeathon	and FAT.			
List of Exp	eriments:	(Indicative)			
1. Design o	of signal con	nditioning circuits for strain gaug	es- Strain, Force, p	ressure,	8 hours
and torque i	neasuremen	nt			
		Strain measurement with Bridge C			
		Beam force sensor using Strain Ga			
		Beam deflection sensing with Strai			
		Diaphragm pressure sensor using S	0 0		
		Shear strain and angle of shift mea			
		st set of characteristics. Design a v			
		a sensitivity of 5 mg. What modif		to do to	
change the	upper range	to 100 Kg with a sensitivity of 10	0 mg.		
2 Develop	a displacem	ent measurement system with the	following sensors:		4hours
2. Develop		nductive transducer (LVDT)	tono wing sensors.		mourb
		Hall effect sensor			
3. After stu		haracteristics of temperature sens	ors listed below. de	evelop a	6hours
		ent system for a particular app		-	
sensor.			0	-	
	i. 7	Thermocouple principles			
		Thermistor and linearization of NT	C Thermistor		

iii. Resistance Temperature Detector						
iv. Semiconductor Ten	nperature sensor	OA79				
v. Current output abso	olute temperature	sensor				
4. Develop a sensor system for force meas	surement using pi	ezoelectric trans	ducer	4hours		
5. Measurement of shear strain and angle twist using strain gauge is not suitable for						
many applications. Based on other sensir	ng experiments c	arried out sugge	est a non-			
contact method and try to complete its pro-	of of concept.					
		Total Laborat	ory hours	30hours		
Mode of Evaluation:Continuous Assessme	ent and FAT					
Recommended by Board of Studies 26-06-2019						
Approved by Academic Council	No. 55	Date	13-06-201	19		

Course code	Course title		L	T	P J	С
ECE5061	IoT Fundamentals and Archite	cture	3	0	0 0	3
Pre-requisite	Nil		Syl	labu	is vers	ion
-					1.00	
Course Objective	es:					
	tion of internet technology and need for IoT.					
	reference layer and various protocols and sof	tware.				
	nts to build IoT systems using sensors, single		rs an	d or	ben sou	ırce
IoT platforms.		1		1		
1	nts to apply IoT data for business solution in	various domain i	n sec	ured	l mann	er.
Expected Course	Outcome:					
1. Identify the IoT	networking components with respect to OS	layer.				
	c for IoT solutions.					
3. Design and dev	elop IoT based sensor systems.					
U	ocols and software.					
	reless technologies for IoT.					
6. Appreciate the	need for IoT Trust and variants of IoT.					
	·					
Module:1 Evol	ution of IoT				7 h o	ours
Review of compu	iter communication concepts (OSI layers, co	mponents, pack	et co	mm	unicat	ion,
Networks, TCP-II	P, subnetting, IPV4 addressing and challenges)	. IPV6 addressin	ng. Io	T ar	chitect	ture
reference layer.			0			
	oduction to IoT components				6 ha	
Characteristics Io	T sensor nodes, Edge computer, cloud an	d peripheral clo	oud,	sing	gle bo	ard
computers, open s	source hardwares, Examples of IoT infrastruct	ure				
	protocols and softwares				6 ho	urs
MQTT, UDP, MQT	TT brokers, publish subscribe modes, HTTP, COA	P,XMPP and gate	eway	proto	ocols,	
Module:4 IoT	1 I				6 ha	urs
	nologies			(
		Wireless technolo	ogies	(6)	LowPA	۹N,
Zigbee, wifi, BI,	BLE,SIG,NFC, LORA,Lifi,Widi)					
Madulas Intra	aduation to Cloud computation and Dig				Cha	
	oduction to Cloud computation and Big analytics				0110	ours
	ud Computation, Commercial clouds and	their features	oper	50	urce	T
	lashboards, Introduction to big data analytics		open	1 30		.01
<u>r</u>						
Module:6 IoT	security				6h 0	ours
	ion, standard encryption protocol, light weight	the cryptography	7. Ou	ıadrı		
• 1	- Threat Analysis and model for IoT-A, Cloud		, ~		r 1	
		7				
Module:7 IoT	application and its Variants.				6 ha	ours
	Γ for smart cities, health care, agriculture, s	mart meters.M2	M. V	Veb		

Cel	lular IoT	, Industrial IoT, Industry 4.	0,IoT standards.			
Mo	dule:8	Contemporary issues:				2hours
			Total Lecture ho	ours:	45hours	
Tex	kt Book(s)				
1.	Sebasti	ndro Bassi, Martin Bauer, an Lange, Stefan Meissner Architecture Reference Mo	, "Enabling things	s to ta	lk – Designin	
2.		ller, Vlasios Tsiatsis, Catl Boyle, "From Machine to M				
Ref	ference l	Books				
1.		Yan Zhang, Laurence T. Y Next-Generation Pervasive N	0	<u> </u>		0
2.		Iadisetti , Arshdeep Bahga, et of Things A Hands-on-A				
3.	Asoke 2010.	K Talukder and Roopa R Y	avagal, "Mobile C	ompu	ting," Tata Mc	Graw Hill,
4	Barrie	Sosinsky, "Cloud Computin	ng Bible", Wiley-In	ndia, 2	010	
5		L. Krutz, Russell Dean V Computing,Wiley-India, 20		ty: A	Comprehens	ive Guide to Secure
Mo	de of Ev	aluation: CAT / Assignmen	t / Quiz / FAT / Pr	oject	/ Seminar	
Rec	commend	led by Board of Studies	26-04-2019			
Ap	proved b	y Academic Council	No. 55	Date	13-06-20)19

Course Code	Course Title	L	Т	P	JC
ECE5062	DATA ACQUISITION	0	0	4	0 2
Pre-requisite	NIL	Syl	labu	s Ver	sion
			1	1.0	
Course Objectives:					
and LabVIEW		_			ware,
	basics of hardware selection, including resolution and			the	
3. To provide kn	sensor connectivity, including grounding and wiring co owledge on using the NI-DAQmx driver to measure, n tasks and analyze the data in MATLAB/ LabVIEW	0		nchro	onize
4. To impart ade	quate knowledge on programming finite and continue in hardware/software timing, triggering, and logging.	ous acquisiti	ons,	as we	ell as
	-on experience configuring and programming NI data	acquisition h	nardv	vare u	using
Course Outcomes:					
2. Understand he subsystems of	ased data acquisition and signal conditioning. ow to control the analog input, analog output, cour a DAQ device.			ligita	1 I/O
	ent types of data acquisition and identify the correct set. Develop integrated, high-performance data acquisition urements			oduc	e
	rom sensors, such as thermocouples and strain gages,	using NI DA	Q		
	analyse the results in LabVIEW and MATLAB	e	-		
5. Apply advance	ed understanding of LabVIEW and the NI-DAQmx AI	PI to create a	pplic	ation	IS
Task 1		8 hours			
1	Programming, NI DAQmx, Data acquisition Toolbox te data into DAQ device.		nto I	MAT	LAB
Task 2		6 hours			
Acquire and generate					
Task 3	6	6 hours			
	non-clocked digital data.				
Task 4		ó hours			
Measure frequency, p	ulse width and count pulses using NI devices				
Task 5	6	6 hours			
Generate Pulse Width		, 11041.5	1		
Task 6	4	4 hours			
Acquire and generate	audio signals		·		
Task 7	6	6 hours			

Simultaneo	us and synchronized data acquisition				
Task 8				4 hours	
Simulink da	ata acquisition				
Task 9				6 hours	
Arduino ba	sed multi-channel data acquisition				
Task 10				8 hours	
Remote dat	a acquisition with NI WSN Gateway	and nodes, CC3	3200 (WiF	i)	
		Total Practic	al Hours	60 hours	
Text Book					
1.	BehzadAhzani "Data Acquisition u	-		-	
2.	Data Acquisition Toolbox – User's	Guide, MathWe	orks, 2016		
Reference	Book(s)				
1.	Lab VIEW: A Developer's Guide to		tegration e	dited by Ian F	air weather,
	Anne Brumfield, 2011, CRC Press.				
2.	DSP for Matlab and LabVIEW: F	undamentals of	discrete s	ignal processi	ng, Morgan
	and Claypool Publishers, 2009				
3.	Maurizio Di Paolo Emilio, "Data	Acquisition S	ystems- F	Fundamentals	to Applied
	Design", Springer, 2013.				
4.	"Data Acquisition Handbook", Me	easurement and o	computing	corporation, 2	012
Mode of Ev	valuation:Continuous Assessment and	d FAT			1
	ded by Board of Studies	26/04/2019	T		
Approved b	y Academic Council	55	Date: 13	/06/2019	

	se Code	Course Title	L	, T	P J	C
ECE5		SYSTEM DYNAMICS AND CONTROL	0	0	4 0	2
Prere	quisite:	Nil				
Cour	se Objectives	•				
	•	• ledge on performance specification, limitations and structure of cor	ntroll	ers		
		ledge on design of controllers using root-locus and frequency doma			ques	
	1				1	
	se Outcome					
1.		need of control system and its recent developments. Able to mod	el the	e sy	stem	and
2	simulate the		•	1 6	·	
2.	domain.	e behavior of the first and second order systems in time doma	in ar	Id T	reque	ency
3		e system stability based on time domain, frequency domain and	root	loci	15	
5.	techniques.	system submy based on time domain, nequency domain and	1001	1000	10	
4.	-	e need for incorporating the three term controller based on the c	ustor	nize	d	
		of the control action				
5.		e systems behavior in digital domain and develop digital control	algo	ithr	n foi	the
T 4 1	$\frac{\text{corrective a}}{\text{P} \cdot \text{corrective}}$	ction.				
1 ext 1	Book(s)	Ogata, "Modern Control Engineering", 2010, 5 th ed., Prentice Ha		ouv	Ioraa	X 7
1.	USA.	Ogata, Modern Control Engineering, 2010, 5 ed., Frence Ha	un, in	CW.	Jeise	y
2.		"Modern Control System Theory", 2014, 2 nd ed. New Age Inte	rnatio	nal	Ne	W
	Delhi, İndi					
Refer	ence Book(s)					
1.	USA.	"Digital control and state variable methods", 2012, 4 th ed., Tata				
2.	ed., PHI, N	Reis, "Programmable Logic Controller - Principles and Applicati New Delhi, India.				
3.		th and M. Gopal, "Control Systems Engineering", 2017, 6 th E al (p) Limited. New Delhi, India.	Ed., 1	√ew	Age	e
List of	f Experimen	ts: (Through Inlab/Remotelab)				
1.	Introduct	on to real time controller system operations	4 hc	urs		
2.	Speed reg	gulation measurement of DC motor using armature control system	4 hc	urs		
3.		gulation and torque measurement of AC Servomotor using control system	4 hc	urs		
4.	Modeling system	and performance analysis of stepper motor position control	4 hc	urs		
5.	Performa estimation	nce analysis of BLDC motor control system and its parameter	4 hc	urs		
6.	ON/OFF	temperature control system using LabVIEW platform	4 hc	urs		
7	Step resp	onse analysis of second order system using Matlab	4 hc	urs		

	d by Academic Council	No. 55	Date	13-06-2019
	ended by Board of Studies	tin Lauca I and Lau.	rai	
Mode of	Evaluation: Continuous Assessme		al Laboratory Hours	60 hours
	& Position Control.			
	d. DC motor speed control (Qua	nser NI Evis) : Model	lling, Speed Control	
	c. HVAC system (Quanser NI E			
	& Up control			
	(b) Inverted pendulum control s	system: Modelling Ba	alance Control design	
	Flight Control			
12	(a) Vertical take-off and landir	ng system- Modelling	, Current Control &	8 hours
	controller			
	c. Comparison of plant p	erformance with PID	vs Fuzzy logic	
	b. Water level controller	using Fuzzy logic co	ntroller	
	with Matlab/MSP430			
	a. Speed regulation of sea	rvo motor using Fuzz	y logic controller	
11	Modelling and implementation of	of		6 hours
10	Modelling and implementation of	of level control system	n using PLC	6 hours
9	Temperature control of a plant platform/MSP430	using PID controller	with LabVIEW	6 hours
8	Frequency response analysis of I	LEAD/LAG compens	sating network	6 hours

Course Code		Course Title		L	Т	Р	J	C
ECE5064	Programmi	ng and scripting la	nguages	0	0	4	0	2
Prerequisite:	Nil			Sy	llabu	is Ve	ersic	n
						1.0		
Course Object	ives:							
1	ose the students to the fur		•	ıg.				
	oduce the GNU C, C++ P		Chain in Linux.					
	y the basic programming	of Python and R.						
Expected Outo								
	roblems using C							
	iate and apply C++							
	tasks using linux scripts	5.						
	anding the basic concept		C mechanisms					
5. Progran	n R for simple data orien	ted applications						
			101					
	nbedded Programming	,,,,,,,	12 hours	. D.(4			1
	g, Declarations and Exp bedded C (Keil).	ressions, Arrays, Po	ointers, Construc	ts, Dat	a str	uctu	res a	and
	bedded C (Kell).							
			101					
	++ Programming.		12 hours		41	:1.		
	lass, objects, member fu functions, constructors, a							
porymorphism	functions, constructors, a	ind destructors Strea	in class to perior		mpu	it-ou	ւքու	
Task 3 Pv	thon Programming		12 hours					
· · · · · ·	s, String manipulation, I	Dictionary, Signal pl		sing, C	Graph	nics		
1			0 1	U,	1			
Task 4 Li	nux		6 hours					
Shell programm	ning, Regular expression	, Process creation, In	nter process com	nunica	tion			
	programming		2 hours					
Data types, Dat	a plotting ,analysis and r	egression, Machine	intelligence					
Text Book(s)								
	ussell, "Introduction to	Embedded system	ns Using ANSI	C an	d th	ne A	rdui	ino
	nent Environment", 2010							
	Rhodes, John Goerzen,	"Foundations of Pyt	hon Network Pro	gramn	ning'	', 20	14, 3	3rd
	on Apress Publisher							
	Grolemund, "Hands-On		R: Write Your	Own	Fur	ictio	ns a	ind
	ons", 2014, Shroff/O'Rei	-		T		~		
	Petersen, "Linux: The	Complete Referenc	e", 2017, Sixth	Edition	n, M	cGra	aw I	Hill
Educatio	on ation:Continuous Assessi	mont and EAT						
	by Board of Studies		26/04/2019					
	cademic Council	No. 55		13/06/2	2019			
rippiored by A		110.35	Duit	13/00/	2017			

ECE5065	Course Title		L	Т	P	J	С
	MICROCONTROLLERS FOR IOT PR	OTOTYPING	2	0	2	0	3
Prerequisite:	Nil		Sy	llab	us V	ersi	ior
			1.()			
*	ives: The course is aimed to						
	e low power microcontrollers and to develo	p the skill set of	pro	ograr	nmir	ng l	OW
1	ensing applications.						
	the knowledge of various peripheral related t	o sensing and con	nm	unica	ation	us	ing
	r wireless means.	DM Carter miss		11			
	e the students by introducing them Advanced A the skill set of students to build IoT systems a				lers		
4. Develo	the skin set of students to build for systems a	ind sensor interrac	mg	•			
Course Outco	nes (CO): At the end of the course the student	should be able to					
1. Design	and develop embedded programs for low powe	er microcontrollers	s foi	r sen	sor		
applicat							
11	ARM basic and advanced programs.						
	e and deploy analog and digital sensors						
	communication system with sensor units						
	develop IoT systems using Wi-Fi CC3200.						
6. Progran	the single board computers to read sensor dat	a and posting in cl	louc	1.			
Clock system,	f the MSP430, Memory, Addressing modes, Re Exceptions: Interrupts and resets. Functions a	nd subroutines, M	lixiı	ng C	and		
	uage, Interrupts, Interrupt service routines, Iss				upts		W
assembly lang power modes of					upts	, LC	W
power modes of	of operation.					, L(W
module:2 A	of operation. RM Cortex MX microcontroller	6 hours					
power modes ofModule:2AARM Cortex M	of operation.	6 hours nology, ARM Inst	truc	tion	set,	Cor	
power modes of Module:2 ARM Cortex M M4 architecture	of operation. RM Cortex MX microcontroller 14: Assembly language basics, Thumb-2 Tech	6 hours nology, ARM Inst	truc	tion	set,	Cor	
power modes of Module:2 A ARM Cortex M M4 architecture Cortex MX Mid	of operation. RM Cortex MX microcontroller 14: Assembly language basics, Thumb-2 Tech e, advantages, peripherals, instruction set, float crocontroller, core, architecture, on-chip wi-fi.	6 hours nology, ARM Inst ing point operatio	truc	tion	set,	Cor	
power modes ofModule:2AARM Cortex MM4 architectureCortex MX MidModule:3D	RM Cortex MX microcontroller 44: Assembly language basics, Thumb-2 Tech e, advantages, peripherals, instruction set, float crocontroller, core, architecture, on-chip wi-fi. isplay and Communication modules	6 hours nology, ARM Inst ing point operation	truc ons,	tion Adv	set, ance	Cor	te
power modes ofModule:2AARM Cortex MM4 architectureCortex MX MidModule:3D	of operation. RM Cortex MX microcontroller 14: Assembly language basics, Thumb-2 Tech e, advantages, peripherals, instruction set, float crocontroller, core, architecture, on-chip wi-fi.	6 hours nology, ARM Inst ing point operation	truc ons,	tion Adv	set, ance	Cor	te
power modes ofModule:2AARM Cortex MM4 architectureCortex MX MidModule:3DGPIO, LCD dcontroller.	RM Cortex MX microcontroller 44: Assembly language basics, Thumb-2 Tech e, advantages, peripherals, instruction set, float crocontroller, core, architecture, on-chip wi-fi. isplay and Communication modules	6 hours nology, ARM Inst ing point operation	truc ons,	tion Adv	set, ance	Cor	te
power modes ofModule:2AARM Cortex MM4 architectureCortex MX MidModule:3DGPIO, LCD dcontroller.Module:4SetSensors interfation	RM Cortex MX microcontroller 44: Assembly language basics, Thumb-2 Tech 45: Assembly language basics, Thumb-2 Tech 46: Assembly language basics, Thumb-2 Tech 47: Assembly language basics, Thumb-2 Tech 48: Assembly language basics, Thumb-2 Tech 49: Assembly language basics, Thumb-2 Tech 49: Assembly language basics, Thumb-2 Tech 40: Assembly language basics, Thumb-2 Tech 41: Assembly language basics, Thumb-2 Tech 42: Assembly language basics, Thumb-2 Tech 42: Assembly language basics, Thumb-2 Tech 43: Assembly language basics, Thumb-2 Tech 44: Assembly language basics, Thumb-2 Tech 44: Assembly language basics, Thumb-2 Tech 44: Assembly language basics, Thumb-2 Tech 45: Assembly language basics, Thumb-2 Tech 46: Assembly language basics, Thumb-2 Tech 46: Assembly language basics, Thumb-2 Tech 47: Assembly language basics, Thumb-2 Tech 48: Assembly language basics, Thumb-2 Tech 48: Assembly language basics, Thumb-2 Tech 49: Assembly language basics, Thumb-2 Tech 49: Assembly language basics, Thumb-2 Tech 40: Assembly language basics, Thumb-2 Tech 40: Assembly language basics, Thumb-2 Tech 40: Assembly language bas	6 hours nology, ARM Inst ing point operation 4 hours ogramming SPI, I2 4 hours SPI thermometer,	truc ons, 2C, I20	tion Adv UAI	set, vance	Cor ed Zigl	
power modes ofModule:2AARM Cortex MM4 architectureCortex MX MidModule:3DGPIO, LCD dcontroller.Module:4SeSensors interfaPWM generation	RM Cortex MX microcontroller 44: Assembly language basics, Thumb-2 Tech 45: Assembly language basics, Thumb-2 Tech 46: Assembly language basics, Thumb-2 Tech 47: Assembly language basics, Thumb-2 Tech 48: Assembly language basics, Thumb-2 Tech 49: advantages, peripherals, instruction set, float 41: crocontroller, core, architecture, on-chip wi-fi. isplay and Communication modules isplay, graphical display, relays, Peripheral pro- nsors interfacing cing techniques- Port Programming, ADC, S	6 hours nology, ARM Inst ing point operation 4 hours ogramming SPI, I2 4 hours SPI thermometer,	truc ons, 2C, I20	tion Adv UAI	set, vance	Cor ed Zigl	te
power modes ofModule:2AARM Cortex MM4 architectureCortex MX MidModule:3DGPIO, LCD dcontroller.Module:4SeSensors interfaPWM generationModule:5MESP8266,Node	RM Cortex MX microcontroller 44: Assembly language basics, Thumb-2 Tech 45: Assembly language basics, Thumb-2 Tech 46: Assembly language basics, Thumb-2 Tech 47: Assembly language basics, Thumb-2 Tech 48: Assembly language basics, Thumb-2 Tech 49: advantages, peripherals, instruction set, float crocontroller, core, architecture, on-chip wi-fi. isplay and Communication modules isplay, graphical display, relays, Peripheral pro- nsors interfacing cing techniques- Port Programming, ADC, Son and demodulation, DTH11, single wire therm icrocontrollers for IoT	6 hours nology, ARM Inst ing point operation 4 hours ogramming SPI, I2 4 hours SPI thermometer, nometer, Frequen	truc ons, 2C, 120 cy c	tion Adv UAI	set, ance	Cor ed Zigl	

Module:6	Single board computers		4	hours	
Raspberry p	bi board, porting Raspbian,	sensor interface ex	xamples,	Python programm	ing for cloud
	or systems using Arduino b		± ′		J
Module:7	Cloud interfacing		2	hours	
Interfacing	and data logging with cloud	: Thing speak, Thi	ngs board	d, Blync platform.	
Module:8	Contemporary Issues		2	hours	
		Total Lect	ure: 30	hours	
Text Book					
1. John H York.	I. Davies, "MSP430 Microc	ontroller Basics", 2	2011, 2 nd	ed., Newnes publis	shing, New
2. Jacob I	Fraden, "Hand Book of Mod	ern Sensors: physi	cs, Desig	gns and Application	ıs", 2014, 4 th
	ringer, New York.				
Reference					-4
publish	Y. Yurish,"Digital Sensors ing, New York.	-		-	
	an W Valvano, "Introduction Space publishing, New Yor		x –M3 N	Aicrocontrollers", 2	2012, 5 th ed.,
3. Muhan	nmad Ali Mazidi, Shujen C	Chen, SarmadNaim			
	mming and Interfacing: Usi	ing C Language",	2015, 2 ^r	^{ad} ed., Mazidi and	Naimi
1	iing, New York.				
	valuation:CAT, Digital Assi	gnments, Quiz, Or	nline cou	rse, Paper publicat	ion, Projects,
	Makeathon and FAT.				1
	eriments: (Indicative)				
	with MSP430 (CCStudio)				6 hours
	Task 1: Port programming of				
	Task 2: Analog to Digital C			nicrocontroller	
	Task 3: LCD display of cha Task 4: Timer	racters and numbe	rs.		
	with ARM (Keil and energ	ia)			8 hours
	Task 1: Peripheral program		ard		8 110018
	Task 2: PWM generation	ining of ARM/ 00	aru		
	Task 3:Configuring CC320) wifi configuratio	on HTTF	P and MOTT	
Prot	0 0	o, whi configuration	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		
	ver wireless transmission us	ing Zigbee			8 hours
	Task 1 : Interfacing Zigbee		SP 430 m	icrocontroller	
	g SPI/UART.				
	Task 2: Programming sleep	and wake up mod	e of MSF	P 430.	
4. IoT syste	ms				8 hours
• Wor	king with Raspberry pi usin	g Python.			
	uino platform				
• Woi	king with open source cloud	ls			
			Total	Laboratory Hours	30 hours
	aluation:Continuous Assess				
	ded by Board of Studies	26/04/2019		-	
Annroved	y Academic Council	55	Date	13/06/2019	

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Course Code	Course Title		L	T]	P J	C
ECE6001	WIRELESS SENSOR NETWORKS AN	D IoT	2	0	(0 4	3
Pre-requisite	ECE 5061- IoT Fundamentals and Architecture		Sy	llab	ous	s Vers	ion
					1	.0	
Course Objectiv							
 protocols 2. To dissem WSNs reg 3. To get the based on query proc 	ate, hardware platforms and software frameworks	c requirements smission capaci plementation is agement, senso	for ty sues r da	app , an ita r	lic d ou	cation solut uting	s in ions and
Course Outcome	s applicability and limitations of communication pro	to colo formant	4	- TT		NT	
 application 2. Confirms based network 3. Proactive transmissi 4. Able to ess 5. Contribute network a 6. Familiariz platform t 7. On a profiday life 	n. the behavior of mobile ad hoc networks (MANETs vorks. in understating the routing protocols function and on delay and bandwidth. tablish networks with an attempt to reduce issue of b e appropriate algorithms to improve existing or to d pplications. e the protocol, design requirements, suitable algorit o meet the industrial requirement. ound level to implement hardware & software for v	a) and correlates their implication their implication roadcast and flo evelop new wir thms, and the state vireless sensor	the ons oodin eles	infr on ng ta s se of-th	ras da ec ns	struct ata chniqu sor •art cl	ies. oud
Module:1	Network for embedded systems	3 hours					
RS232, RS485, S	PI, I2C, CAN, LIN, FLEXRAY.						
Module:2	Embedded wireless communication and Protocols	5 hours					
Bluetooth, Zigbee	wifi, MiWi, Nrf24, Wireless LAN & PAN, UWB						
Module:3	Wireless sensor network (WSN)	4 hours					
transceiver design	l challenges, WSN vs Adhoc Networks, Sensor no a considerations in WSNs, Energy usage profile, Ch tion scaling, Antenna considerations.		•			•	anc
Module:4	WSN (Medium access control)	5 hours					
Fundamentals of	MAC protocols - Low duty cycle protocols and wa ule-based protocols - SMAC – BMAC, Traffic-a	akeup concepts,	, Co m a	nten	nti ss	on B prot	ased ocol

Module:5	Sensor Network Architecture	5 hours
Data Diss	emination, Flooding and Gossiping-Data gathering Sensor I	Network Scenarios, Optimization
	Figures of Merit, Design Principles for WSNs- Gateway Co et Communication, WSN Tunneling	oncepts, Need for gateway, WSN
Module:6	IP based WSN	4 hours
	itching, packet switching, concept of IPV4, IPV6, 6LOW N based WSN.	PAN and IP, IP based WSN,
Module:7	Tiny OS	2 hours
	or WSN and IoT, M2M communication, Alljoyn network	2 1001 \$
1111 05 10	i worvand for, wizhi communication, Anjoyn network	
Module:8	Contemporary issues	2 hours
	Total Lecture hours:	30 hours
Text Book	s(s):	
1.	Holger Karl, Andreas Willig, "Protocols and Architecture 2011, 1 st ed., John Wiley & Sons, New Jersey.	s for Wireless Sensor Networks"
2	Jun Zheng, Abbas Jamalipour, "Wireless Sensor Networ 2014, 1 st ed., Wiley-IEEE Press, USA.	rks: A Networking Perspective",
Reference	Book(s)	
1.	Waltenegus W. Dargie, Christian Poellabauer, "Fund Networks: Theory and Practice", 2014, 1 st ed., John Wiley	
2	Ian F. Akyildiz, Mehmet Can Vuran, "Wireless Sensor Wiley & Sons, New Jersey.	
3	Zach Shelby, Carsten Bormann, "6LoWPAN: The Wirele ed., John Wiley & Sons, New Jersey.	ess Embedded Internet", 2009, 1 ^s
	Evaluation:CAT, Digital Assignments, Quiz, Online cour	se, Paper publication, Projects,
	/Makeathon and FAT	
	ojects: (Indicative) 15 Hours	
	loor locks offer sophisticated "access control" features to a	
	e Bluetooth and NFC can enable a door to unlock whenever	-
	s. Users can also remotely lock and unlock the door, or s ing mobile apps. Keeping the above design parameters	
	s security using IoT principle.	implement a small locks lo.
	igerator is the most frequently used domiciliary/kitchen electorage. Implement a Smart refrigeration module designed	11

2. The refrigerator is the most frequently used domiciliary/kitchen electrical appliance all over the world for food storage. Implement a Smart refrigeration module designed to convert any existing normal refrigerator into a smart and low-cost machine using sensors. Smart refrigerator compares the status of the food for e.g. weight, quantity etc. The smart refrigerator must also able be remotely controlled and notifies the user about scarce products via wifi module (internet) on user's mobile android application. Add functionality which includes the ice ready indication, power saving, smell detection, overweighting etc.

3. Water has become a scarce resource and is crucial to the production of food. Therefore, design and implement a wireless sensor network to manage and conserve this vital resource. Part of the system

includes the design and development of three sensor nodes to monitor soil moisture. An interface to display and store the status of the water content and also to be uploaded to a web server.

4. Design and provide necessary modules and service, such as command dissemination, feedback module, data logging and collection module, network programming module and time synchronization service between different sensor nodes.

5. WSN has a variety of services based on sensor network architecture. Common issues such as network bandwidth reduction, collision occurrence and performance deterioration due to the broadcasting of message in large-scale networks have become main challenges. To overcome these issues implement routing algorithm based on data-centric routing and address-based routing schemes, by which the query messages are delivered to the target area by using address-based routing scheme, then, the broadcast scheme.

Mo	de of Evaluation:Review I,II,III				
	Recommended by Board of Studies	26/04/2019			
	Approved by Academic Council	No. 55	Date	13/06/2019	

Course Co	le Course Title		LTP	J	C
ECE6030		NAL VTICS	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	0	3
Pre-requisi			Syllabus v	-	
11c-requisi	te ECES002 - Data Acquisition		v.1	CI SI	UII
Course Ob	actives.		V.1		
>	ntroduce the concepts of <i>discrete</i> time <i>signal pro</i>	cassing and the	characteriz	atio	
	ndom signals.	cessing and the	characteriz	auo	11
	resent the basic theory of modeling the signals	and the methods	s of estimat	ing	the
	owns using prediction filters	and the methods	s of estimat	ing	une
	rovide a comprehensive understanding on applyin	or FFT DCT and	d wavelet		
	niques for extracting the signal features.	ig 11 1, De 1, un			
	rovide an overview of analysing big data using int	telligent techniqu	ies and an ir	-det	oth
	duction to two main areas of <i>Machine Learning</i> :				Jui
		supervised and a	lisaperviseu		
Expected C	ourse Outcomes:				
-	y FFT, DCT wavelet techniques for extracting the	e features from th	ne big data		
	elop algorithms that can be used to analyse the rea		-	varis	ate
	series data.			vuin	110
		41	••••••		
	gn an approach to leverage data using the steps in		• •		
	erstand and apply both supervised and unsupervise	ed classification	methods to	dete	ct
and	characterize patterns in real-world data.				
5. Estir	nate the signal parameters and identify the model	using ARMA mo	odels and		
pred	iction filters.				
6. Und	erstand the methods of visualization and analysis	of big data.			
	- -	e			
		Γ			
Module:1	Discrete Random Signal Processing	4 hours			
	cesses, Ensemble Average, Gaussian Process, Mu				
	rocess, Autocorrelation, Auto Covariance, Ergodi	city, White noise	e, Power Spe	ectru	ım,
Filtering of	Random Process				
Module:2	Signal Modeling	4 hours			
AKMA, AR	, MA Models. Wiener filter, Linear prediction, Ka	alman Filter.			
Module:3	Feature extraction	4 hours			
FFT, Power	spectrum, DCT, filter banks, Wavelet, Wavelet F	Packets, Cepstrun	n		
	70'	41.			
Module:4	Time series analysis	4 hours	•		
	sis, Univariate time series analysis, Multivariate	time series analy	sis, non sta	tion	ary
time series.					
		41			
Module:5	Reduction of dimensionality	4 hours			
•	cision, Linear discrimination, Principal Compo	nent analysis, S	SVD, Indep	ende	nt
Component	Anaiysis.				
Module:6	Machine learning	4 hours			

М	ndule•7	Big Data Analytics		4 hours						
		Big data analytics, visualiz	vation and data e		vic and intermediate					
		ear and logistic regression, dec			sie and intermediate					
		Contemporary Issues			2 hours					
		F F F F F F F F F F								
			Total Lecture	: 30 hours						
Te	xt Book	(s)								
1.		Proakis, DG. Manolakis and applications", 2012, 4			rocessing principles,					
2.		cles J. Orfanidis, "Inroduction			l., Prentice Hall, New					
Re	ference	Books								
1.		hiem V. A.V and Schaffer R. V e Hall,. New Delhi, India	W, "Discrete- time	e signal Process	ing", 2014, 3 rd ed.,					
2.			Prentice Hall,. New Delhi, India Thomas A. Runkler, "Data Analytics: Models and Algorithms for Intelligent Data							
	Analys	is", 2016, 2 nd ed., Springer Ven	rlag, UK							
3.		P. Murphy, "Machine Learnin		c Perspective"	2012, 1 st ed., MIT					
Mo Pro	Kevin Press, ode of E ojects, Ha	P. Murphy, "Machine Learnin USA Evaluation: CAT, Digital Ass ackathon/Makeathon and FAT	ng: A Probabilisti signments, Quiz,							
Ma Pra Li s	Kevin Press, ode of E ojects, Ha	P. Murphy, "Machine Learnin USA Evaluation: CAT, Digital Ass ackathon/Makeathon and FAT Illenging Experiments (Indica	ng: A Probabilisti signments, Quiz, ative)	Online course	, Paper publication,					
Mo Pro Lis 1.	Kevin Press, 1 ode of E ojects, Ha st of Cha Design	P. Murphy, "Machine Learnin USA Evaluation: CAT, Digital Ass ackathon/Makeathon and FAT Illenging Experiments (Indica and implementation of Wiene	ng: A Probabilisti signments, Quiz, ative) r filter and Kalma	Online course	Paper publication,					
Mo Pro Lis 1.	Kevin Press, 1 ode of E ojects, Ha st of Cha Design process	P. Murphy, "Machine Learnin USA Evaluation: CAT, Digital Ass ackathon/Makeathon and FAT Ilenging Experiments (Indica and implementation of Wiene and implementation of filter b s (speech, audio).	ng: A Probabilisti signments, Quiz, ative) r filter and Kalma banks and wavelets	Online course n filter. s for random	Paper publication,					
Mo Pro Lis	Kevin Press, 1 ode of E ojects, Ha st of Cha Design process Design	P. Murphy, "Machine Learnin USA Evaluation: CAT, Digital Ass ackathon/Makeathon and FAT Illenging Experiments (Indica and implementation of Wiene and implementation of filter b	ng: A Probabilisti signments, Quiz, ative) r filter and Kalma panks and wavelets pal Component Ar	Online course n filter. s for random	Paper publication,					
Mc Pro Lis 1. 2. 3.	Kevin Press, J ode of E ojects, Ha st of Cha Design process Design and Sin Design	P. Murphy, "Machine Learnin USA Evaluation: CAT, Digital Ass ackathon/Makeathon and FAT Illenging Experiments (Indica and implementation of Wiene and implementation of filter b s (speech, audio). and implementation of Princip	ng: A Probabilisti signments, Quiz, ative) r filter and Kalma panks and wavelets pal Component Ar D).	Online course n filter. s for random nalysis (PCA)	 Paper publication, 6 hours 6 hours 					
Mc Pro Lis 1. 2.	Kevin Press, 1 Dede of E Design Design Design and Sin Design speake Consid	P. Murphy, "Machine Learnin USA waluation: CAT, Digital Ass ackathon/Makeathon and FAT illenging Experiments (Indica and implementation of Wiene and implementation of filter b s (speech, audio). and implementation of Princip ngle Value Decomposition (SV an expert system for simple ap r recognition, face recognition) er a real time data available in	ng: A Probabilisti signments, Quiz, ative) r filter and Kalma oanks and wavelets pal Component Ar D). pplication (speech). college campus ar	Online course n filter. s for random nalysis (PCA) recognition, nd develop a dat	 Paper publication, 6 hours 6 hours 6 hours 6 hours 6 hours 6 hours 					
Mc Pro Lis 1. 2. 3. 4.	Kevin Press, 1 Dede of E Design Design Design and Sin Design speake Consid	P. Murphy, "Machine Learnin USA Evaluation: CAT, Digital Ass ackathon/Makeathon and FAT Illenging Experiments (Indica and implementation of Wiene and implementation of filter b s (speech, audio). and implementation of Princip ngle Value Decomposition (SV an expert system for simple ap r recognition, face recognition)	ng: A Probabilisti signments, Quiz, ative) r filter and Kalma panks and wavelets pal Component Ar D). pplication (speech). college campus an age, trend and pree	Online course n filter. s for random nalysis (PCA) recognition, nd develop a dat	 Paper publication, 6 hours 					
Mc Pro Lis 1. 2. 3. 4. 5.	Kevin Press, 1 December 2015 St of Cha Design Design and Sin Design speake Consid analyti	P. Murphy, "Machine Learnin USA waluation: CAT, Digital Ass ackathon/Makeathon and FAT illenging Experiments (Indica and implementation of Wiene and implementation of filter b s (speech, audio). and implementation of Princip ngle Value Decomposition (SV an expert system for simple ap r recognition, face recognition) er a real time data available in	ng: A Probabilisti signments, Quiz, ative) r filter and Kalma banks and wavelets pal Component Ar D). pplication (speech). college campus an age, trend and pred	Online course n filter. for random nalysis (PCA) recognition, nd develop a dar diction	 Paper publication, 6 hours 					
Mc Prc Lis 1. 2. 3. 4. 5.	Kevin Press, 1 Dede of E Design Design Design and Sin Design speake Consid analyti	P. Murphy, "Machine Learnin USA waluation: CAT, Digital Ass ackathon/Makeathon and FAT Illenging Experiments (Indica and implementation of Wiene and implementation of filter b s (speech, audio). and implementation of Princip ngle Value Decomposition (SV an expert system for simple ap r recognition, face recognition) er a real time data available in c system to determine the avera	ng: A Probabilisti signments, Quiz, ative) r filter and Kalma banks and wavelets pal Component Ar D). pplication (speech). college campus an age, trend and pred	Online course n filter. for random nalysis (PCA) recognition, nd develop a dar diction	 Paper publication, 6 hours 					

Course code	e	Course title	<u> </u>		P	J	C
ECE5006		FLEXIBLE AND WEARABLE SE			0	0	3
Prerequisite	:	ECE5001-Principles of Sensors	<u> </u>	Syllal		versi	on
~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~ ~					1.1		
Course Obje							
-		the overview of flexible electronics techno	ology and the issue	es wi	th m	ateri	als
-	0	or thin film electronics.	1	. J. C	1.	:	
	-	he students for the materials selection and levelopment.	a patterning metho	oas i	or th	in ri	um
		the process involved in transferring the	flevible electroni	e fra	om f	Coile	to
		also the challenges, opportunities and the fu				0115	iC
		ne students to the design, challenges of wea				sens	ing
		and biological parameters and the proce					
		and semiconducting fibers to smart textiles.					
Expected Co							
		echnology developments in the flexible electronic states and its sub-			- f 41	·	1
	ty to 1a	entify the suitable materials and its processi	ng for the develop	ment	of th	11n T1	IIm
		sign the pattern and develop with suitable p	etterning methods				
		process involved in the transformation of ele			xtile	s	
		house of the mansformation of the					
5. Acqu	ire the	design knowledge for developing wearable	e sensors for physi	cal ar	nd cł	nemi	ca
		design knowledge for developing wearable	e sensors for physi	cal ai	nd cł	nemi	cal
paran	neters	design knowledge for developing wearable mpetency in transferring the conducting an					
paran	neters the co						
paran 6. Gain textile	neters the contes	mpetency in transferring the conducting an			rs to	sma	art
6. Gain textile	neters the co es Overv	mpetency in transferring the conducting an iew of flexible electronics technology	nd semiconducting	g fibe	rs to	5 ho	art urs
paran 6. Gain textile Module:1 History of t	neters the cores Overv flexible	iew of flexible electronics technology e electronics - Materials for flexible elec	nd semiconducting	g fibe	rs to	sma 5 hou iblil	art urs ity
6. Gain textile Module:1 History of t substrates, ba	neters the cores overv flexible ackplar	iew of flexible electronics technology e electronics - Materials for flexible electronics, front plane technologies, encode	nd semiconducting ectronics: degrees apsulation - Fabric	g fibe	rs to flex tech	sma 5 ho u iblil	art urs ity
6. Gain textile Module:1 History of t substrates, ba for flexible e	neters the co es Overv flexible ackplar electron	iew of flexible electronics technology e electronics - Materials for flexible elec	nd semiconducting ectronics: degrees apsulation - Fabric	g fibe	rs to flex tech	sma 5 ho u iblil	art urs ity
6. Gain textile Module:1 History of t substrates, ba for flexible e Roll processi	neters the co es Overv flexible ackplar electron ing - Ac	iew of flexible electronics technology e electronics - Materials for flexible electronics, front plane technologies, enci ics - Fabrication on sheets by batch process dditive printing.	nd semiconducting ectronics: degrees apsulation - Fabric	g fibe	rs to flex tech by I	sma 5 hor iblil iblil nolo Roll-	art urs ity ogy to-
6. Gain textile Module:1 History of t substrates, ba for flexible e Roll processi	neters the cores Overv flexible ackplar electron ing - Ac Amor	iew of flexible electronics technology e electronics - Materials for flexible electronics, front plane technologies, enci ics - Fabrication on sheets by batch process dditive printing.	nd semiconducting ectronics: degrees apsulation - Fabric	g fibe	rs to flex tech by I	sma 5 ho u iblil	urs ity ogy to-
6. Gain textile Module:1 History of t substrates, ba for flexible e Roll processi Module:2	neters the co es Overv flexible ackplar electron ing - Ac Amorj materi	iew of flexible electronics technology e electronics - Materials for flexible electronics, front plane technologies, encodes ics - Fabrication on sheets by batch process dditive printing.	nd semiconducting ectronics: degrees apsulation - Fabric ing, fabrication or	g fibe	rs to flex tech by I	5 hor iblil nolo Roll- 7 hor	urs
6. Gain textile Module:1 History of t substrates, ba for flexible e Roll processi Module:2 Fundamental	overv flexible ackplar electron ing - Ac Amorj materi l issue	iew of flexible electronics technology e electronics - Materials for flexible electronics, front plane technologies, enci ics - Fabrication on sheets by batch process dditive printing.	nd semiconducting ectronics: degrees apsulation - Fabric ing, fabrication or emperature amor	g fibe	rs to flex tech by I	sma 5 hou iblil nolc Roll- 7 hou 1 nat	art urs ity bgy to- urs
6. Gain textile Module:1 History of t substrates, ba for flexible e Roll processi Module:2 Fundamental crystalline si	overv flexible ackplar electron ing - Ac Amorj materi l issue ilicon	iew of flexible electronics technology e electronics - Materials for flexible electronics, front plane technologies, enci ics - Fabrication on sheets by batch process dditive printing.	nd semiconducting ectronics: degrees apsulation - Fabric ing, fabrication or eemperature amorg ectric thin film of	g fibe of ation web	rs to	sma 5 hou iblil nold Roll- 7 hou 1 na - 1	art urs ity ogy to- urs
6. Gain textild Module:1 History of t substrates, ba for flexible e Roll processi Module:2 Fundamental crystalline si temperature	neters the co es Overv flexible ackplar electron ing - Ac Amorj <u>materi</u> 1 issue ilicon silicon	iew of flexible electronics technology e electronics - Materials for flexible electronics, front plane technologies, enc. ics - Fabrication on sheets by batch process dditive printing.	nd semiconducting ectronics: degrees apsulation - Fabric ing, fabrication or ectric thin film of - Device structure	g fibe of ation web	rs to	sma 5 hou iblil nold Roll- 7 hou 1 na - 1	art urs ity ogy to- urs
6. Gain textild Module:1 History of t substrates, ba for flexible e Roll processi Module:2 Fundamental crystalline si temperature	neters the co es Overv flexible ackplar electron ing - Ac Amorj <u>materi</u> 1 issue ilicon silicon	iew of flexible electronics technology e electronics - Materials for flexible electronics, front plane technologies, enci ics - Fabrication on sheets by batch process dditive printing.	nd semiconducting ectronics: degrees apsulation - Fabric ing, fabrication or ectric thin film of - Device structure	g fibe of ation web	rs to	sma 5 hou iblil nold Roll- 7 hou 1 na - 1	art urs ity ogy to- urs no-
A param 6. Gain textile Module:1 History of t substrates, ba for flexible e Roll processi Module:2 Fundamental crystalline si temperature processing - 1	neters the cores Overv flexible ackplar electron ing - Ac Amorj mater l issue ilicon silicon Device	iew of flexible electronics technology e electronics - Materials for flexible electronics, front plane technologies, enca ics - Fabrication on sheets by batch process dditive printing.	nd semiconducting ectronics: degrees apsulation - Fabric ing, fabrication or ectric thin film of - Device structure	g fibe of ation web	flex tech by I	sma 5 hou iblil nold Roll- 7 hou 1 na - 1	art urs ity ogy to- urs no- ow als
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sma	art textile	es - Improvements and limita	ations.		
Me	dule:5	Wearable haptics			6 hours
		-	earables - Textiles	and cl	othing: The meta wearable -
		and opportunities - Future of			
Cat	egories o	of wearable haptic and tactile	e display.		_
Mo	dule:6	Wearable Bio, Chemical	and Inertial senso	rs	6 hours
					nical sensing - Application areas
					sors - Applications for wearable
			ons for wearable in	nertial s	ensor - Application in clinical
pra	ctice and	future scope			
1.5				1	
		Knitted electronic textiles			6 hours
		to textile sensors - Interlace			1. 0
	0	U			ing by textile sensors and other
app	olications	. FBG sensor in Intelligent (Jothing and Biome	chanics	•
Ма	dule:8	Contemporary issues:			
IVIO	ouule:0	Contemporary issues:			7 hours
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Course cod	e	Course title		L	T	P	J	C
ECE5008		MICRO AND NANO FLUID	DICS	2	0	0	4	3
Prerequisit	e: Nil			Sy	yllat	ous v	vers	
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Course Obj					~			
		scuss the fundamental physics of mi	cro and nano sca	le f	luid	s ar	id th	iei
•	odynamics.				(1		
		hniques of miniaturization, methods a		mı	croi	luia	IC	
		discuss various existing microfluidic ntify the usage of microfluidics in		in	and	hior	·00.01	tor
	ications	htty the usage of interoflutures in	various lab-oli-cli	np	anu	0101	Caci	101
11		compare microfabrication techniques t	o design vasculati	ure	and	3D	mic	ro
chan		ompare interoracineation teeninques t		are	und	50	mie	10
Expected C	ourse Outco	ome:						
1. Ident	tify and unde	erstand the fundamental physics of mic	cro and nano scale	e flu	iids	and	thei	r
hydr	odynamics.	Comprehend the basics of miniaturizat	tion, methods and	toc	ols to	o cre	ate	
	ofluidic arch							
	-	terpret the working principle of variou	-	uid	lic d	evic	es.	
		microfluidic lab-on-chip applications.						
		rious bioreactor based microchips	• • • •		1.4		1.0	חו
		ompare various microfabrication techr	iques to design va	asc	ulati	ire a	nd 3	5D
		vith existing techniques. lation and microfluidic device fabricat	ion knowledge fo	r da	امىد	nin	a	
	ous microflui		ion knowledge io	I ut		Jhu	g	
vano								
Module:1		tals for Microscale and Nanoscale	5 hours					
	Flow				-			-
		operties of fluids, classification of flu						
· •		low, reynolds number, Electrokinetic	± .				•	
• •		species transport and fluid mechanic ow through porous media, Diffusion,						
Wetting.	lary now, n	ow through porous media, Diffusion,	surface tension,	COI	Itaci	. ang		1110
Module:2	Hydrodyna	amics	4 hours					
		surface charge, surface energy, Ther					uids	in
Electrical fie	elds, The Na	avier Strokes equation, Boundary and	Initial conditions p	pro	blen	ns,		
			1					
Module:3		n methods and techniques	4 hours					
Patterning,			olding, Soft lith	nog	raph	ıy,	PDI	M.
properties, F	abrication o	f microfludics channels.						
Modular	Mionafi	ia Daviana	2 hours					
Module:4	Microfluid		3 hours	4 ¹	'	07-	ro1-	0.5
1		ctive Flow control, Microvalves, I lonal Mixers, Elastomeric Micromixer	•	ueo	i m	CIO	valV	εs,
wheromixers	s, comonali	onai witzers, Elastometre witeromizer	0					
Module:5	Microfluid	ics Lab on Chip	3 hours					

me ass	Bioreactors on Microchip	<u>s</u>			
	ay and inhibition Chamia	0		4 hours	
	tion in micro reactors, chem				ential reaction and y
ule:7	3D Vascular Network for	Engineered tissu	es	5 hours	
o-mach	Microfabrication of vascul ined 3D channels, Introduc els in Microfludics Model bu	tion to Comsol M			·
ule:8	Contemporary issues:				2 hours
	,	Total Lecture ho	urs:	30 hours	
Book(s)				
Cleme	nt Kleinstreuer, "Micro				ory and Selected
Shaury	a Prakash, JunghoonYeo	m, "Nanofluidic	s an	d Microfluid	dics: Systems and
rence l	Books				
		Microfluidics",	2011,	Reprint ed.,	Oxford University
			for B	iomedical Ap	plications", 2013, 1 st
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of ass	essment: Continuous Assess	ment and FAT			
			Date	05-10-20	017
	Applica App	Contemporary issues: Ile:8 Contemporary issues: Book(s) Book(s) Clement Kleinstreuer, "Micro Applications",2013, 1 st ed., John V haurya Prakash, JunghoonYeo Applications",2014, 1 st ed., William ence Books Albert Folch, "Introduction to BioM Patrick Tabeling, Camb Terrence Conlisk. A, "Essentials Biological and Chemical Sciences' of Evaluation: CAT / Assignment of assessment: Continuous Assess nmended by Board of Studies	channels in Microfludics Model builder. Ide:8 Contemporary issues: Total Lecture how Book(s) Clement Kleinstreuer, "Microfluidics and N Applications",2013, 1 st ed., John Wiley & Sons, New haurya Prakash, JunghoonYeom, "Nanofluidic Applications",2014, 1 st ed., William Andrew; Norwic ence Books Albert Folch, "Introduction to BioMEMS", 2012, 1 st ed. Patrick Tabeling, "Introduction to Microfluidic Devices ed., Wood head Publishing, Cambridge. Terrence Conlisk. A, "Essentials of Micro- and N Biological and Chemical Sciences", 2012, 1 st ed., Ca of Evaluation: CAT / Assignment / Quiz / FAT / Pro of assessment: Continuous Assessment and FAT nmended by Board of Studies 21-08-2017	channels in Microfludics Model builder. Ide:8 Contemporary issues: Total Lecture hours: Total Lecture hours: Book(s) Clement Kleinstreuer, "Microfluidics and Nanofl Applications",2013, 1 st ed., John Wiley & Sons, New Jerse haurya Prakash, JunghoonYeom, "Nanofluidics and Applications",2014, 1 st ed., William Andrew; Norwich, New ence Books Albert Folch, "Introduction to BioMEMS", 2012, 1 st ed., CF Patrick Tabeling, "Introduction to Microfluidics", 2011, Press, Great Britain. Xiujun James Li, Yu Zhou , "Microfluidic Devices for B ed., Wood head Publishing, Cambridge. Terrence Conlisk. A, "Essentials of Micro- and Nanofl Biological and Chemical Sciences", 2012, 1 st ed., Cambrid of Evaluation: CAT / Assignment / Quiz / FAT / Project / Of assessment: Continuous Assessment and FAT nmended by Board of Studies	Ide:8 Contemporary issues: Total Lecture hours: 30 hours Book(s) 30 hours Clement Kleinstreuer, "Microfluidics and Nanofluidics: The Applications",2013, 1 st ed., John Wiley & Sons, New Jersey. haurya Prakash, Junghoon Yeom, "Nanofluidics and Microfluid Applications",2014, 1 st ed., William Andrew; Norwich, New York. ence Books Jibert Folch, "Introduction to BioMEMS", 2012, 1 st ed., CRC Press, Uni Patrick Tabeling, "Introduction to Microfluidics", 2011, Reprint ed., Press, Great Britain. Xiujun James Li, Yu Zhou , "Microfluidic Devices for Biomedical Apple. Terrence Conlisk. A, "Essentials of Micro- and Nanofluidics: With Biological and Chemical Sciences", 2012, 1 st ed., Cambridge University of Evaluation: CAT / Assignment / Quiz / FAT / Project / Seminar of assessment: Continuous Assessment and FAT nmended by Board of Studies 21-08-2017

Course Code	Course Title		ΓΡ	J	С
ECE5066	Chemical and Environmental Sensor	2 (0 2	0	3
Pre-requisite:	ECE5060-Principles of Sensors and Signal Conditioning	Syll	abus '	Versi	on
		-	1.0)	
Course Objectiv	ves				
 To extend understat To propo- detection To be ex- gases usin Ability to sensitive Course Outcom Realize th Apply the Be famili- be applie Ability to Gain kno Able to o common Evaluate 	d engineering principles to electrochemical sensor developm ing of oxidation and reduction of an electrolytic cell. bund the conception of ion selective and enzyme stabilized of chemical and biomolecules. pedient in applying specific interaction methods in the recog ng metal oxide based sensors. o analyze the modes of vibration and develop the suitable n sensors. es he need for half-cell and to analyze potential developed in any e same for ion selective measurement iar with a wide range of chemical sensing methods and mate d in biosensors. o design gas sensors for commercial and industrial application wledge of nanomaterials for biological and medical application discuss, develop and apply site specific antigen-antibody ser diseases like metabolic disorders process design criteria for gas treatment and air quality analys	l electro nition c nass and y electro erial ch ss. ons nsors do	odes for of ion d therr ochem aractes	or the select nal ical c ristics	eell. s to
Module:1	Electrochemistry			4 ho	
Cells, Electrode	es, , Enthalpy, Entropy, Gibbs free Energy, Law of Mass Ac – Electrolyte Interface, Fluid Electrolytes, Dissociation of Sa Value, Ionic Conductivity, Ionic Mobility, Phase Diagrams.				
Module:2	Transduction Principles			4 ho	ure
Transduction E Selective Electro	Elements- Electrochemical Transducers-Introduction Pote odes: The Nernst Equation Voltametry and amperometry, con odes, Thin-Film Electrodes and Screen-Printed electrodes, pho	nductiv	ity, FI	nd I ET,	ion-
Module:3	Chemical Sensing Elements			4 ho	urs
biological recog	n, molecular recognition-chemical recognition agent, specinition agents. Immobilization of biological components, per , Amino Acid Biosensors, Glucose Biosensors and Uric Acid	erforma	nce fa	actors	s of
Module:4	Potentiometric and Amperometric Sensors			4 ho	urs
linked, Iodine s electrodes: subst	Ion selective electrodes- pH linked, Ammonia linked, CO2 selective, amperometric -bio sensors and gas sensors, A rate and enzyme activity, Detection mode and transduction r des, pH glass and ion selective electrodes, solid state and redo	mperor nethod,	netric , medi	enzy	me
Module:5	Optical Biosensor and Immunosensors Biosensor			4 ho	urs
Fiber optic bios	sensor, Fluorophore and chromophore based biosensor, E	Biolumi	nescer	nce a	nd

chemiluminescence based biosensors, Non labled and labled immune sensors, Microbial Biosensors: electrochemical, photomicrobial, Microbial thermistor. Application of microbial biosensors in glucose, ammonia, acetic acid, alcohol, BOD, methane sensing

Module:6Sensors in exhaust gas treatment4 hoursEngine combustion process, Catalytic exhaust after treatment, Emission limits, Exhaust sensors and Engine
control, Emission test cycles, On-board diagnose (OBD): Diagnose Strategies, Exhaust sensors for OBD,
Control Sensors: Hydro-Carbon Sensors, NOx-Sensors, Temperature Sensors, Oxygen Sensors.

Module:7 Measurement techniques for air quality 4 hours Measurement techniques for particulate matter in air. Specific gaseous pollutants analysis and control- Measurement of oxides of sulphur, oxides of nitrogen unburnt hydrocarbons, carbonmonoxide, dust mist and fog. Module:8 **Contemporary Issues** 2 hours **Total Lecture:** 30 hours Text Book(s) Janata, Jiri, "Principles of Chemical sensors", 2014, 2nd edition, Springer, New York. **Reference Book(s)** Brian R Eggins, "Chemical Sensors and Biosensors", (Part of AnTS Series), 2010, 1st 1. edition, John Wiley Sons Ltd, New York. 2 Peter Grundler, "Chemical Sensors: Introduction for Scientists and Engineers", 2011, 1st edition, Springer, New York. R.G.Jackson, "Novel Sensors and Sensing", 2012, 1st edition, Philadelphia Institute of 3. Physics. 4 Florinel-Gabriel Banica "Chemical Sensors and Biosensors: Fundamentals and Applications" 2012, 1st edition, Wiley-Blackwell, New Jersey. M. Campbell, "Sensor Systems for Environmental Monitoring: 5. Volume Two: Environmental Monitoring", 2011, 1st Edition, Springer, New York. Mode of Evaluation:CAT, Digital Assignments, Quiz, Online course, Paper publication, Projects, Hackathon/Makeathon and FAT List of Challenging Experiments: (Indicative) Develop a suitable electrochemical cell which can distinguish normal and 6 hours 1 contaminated water samples. Cyclic voltammetry technique can be used as the detection method. Develop the electronic circuitry and display to indicate the type of water. 2 Interdigitated Electrodes (IDT) are required for effective chemical sensing 6 hours application. Using copper as the electrode material, develop IDT finger type electrodes using suitable deposition method. 3 After analysing the advantages and drawbacks of various methods used for 6 hours depositing the oxide materials on planar rigid substrates, deposit zirconium oxide on the IDT electrodes fabricated on alumina substrate using the suitable deposition method. 4 Among the various types of conductometric sensors, identify a suitable 6 hours sensor which can measure the humidity and develop asensor system which can measure the relative humidity in the range of 40 to 60 percent.

5	Develop a potentiostat circuit f for gas sensing application. The				6 hours
	to 130 ohms and the expected				
	electronic circuit which can co	nvert the char	nge in resistance in to	a voltage	
	signal/current signal.				
			Total Laborat	ory Hours	30hours
Mode of	of Evaluation: Continuous Assess	sment and FA	Т		
Recom	mended by Board of Studies		26-04-2019		
Approv	ved by Academic Council	No. 55	Date	13-06-20	19

Course cod	le	Course Title	L	Τ	Р	J	С
ECE5067		Cloud and Fog Computing	2	0	2	0	3
Prerequisit	te	ECE5061- IoT Fundamentals and Architecture	Sy	llab	us V	ersi	ion
			+		1.00		
Objectives:			<u> </u>				
The course i	s ai	med to					
1. Introduce	clo	ud computing and enabling technologies					
2. Explore th	ne n	eed for fog and edge computation					
3. Impart the	e kn	owledge to log the sensor data and to perform further data analy	ytics				
Expected O	utc	ome:					
At the end of	f th	e course student will be able to					
1. Deploy th	eir	data in the cloud for simple applications					
2. Apply the	ana	alytics in cloud to extract information					
3. Appreciat	e ar	nd deploy fog data processing layers					
4. Integrate s	sens	sor data to cloud through fog computation layers					
5. Understan	nd a	nd implement edge computation					
6. Develop	edg	e analytics using python and tensor flow					
7. Perform of	data	pushing and processing in commercial clouds.					
Module 1	Cle	oud Computing basics and enabling			5	5 ho	urs
	tec	hnologies					
		computing-Need for clouds- concepts and models: Roles and					
		 Cloud delivery models – Cloud deployment models. Broad cture – Data Center Technology – Virtualization Technology. 	band	Ne	twoi	KS a	ind
Module 2	Cl	oud Virtualisation			5	hou	urs
Server orien	ted	– Virtual Machines (IaaS), Modern Serverless Configurations-	Fun	ctio	ns/ (Paas	5)
		ns – App, Biz function, logics, data ingestion (elasticity, scalab					·
DB services.	, Ar	nalytics services (SaaS).					

Module 3	Cloud Application Development in Python	4 hours
Python for MapReduce	Cloud: Amazon Web Services – Google Cloud e.	– Windows Azure. Python for
Module 4	Federated Cloud Service Management and IoT	3 hours
	vice management (federated) –Cloud Life Cycle-se es -Self organizing cloud architectures	rvice and management-Cloud
Module 5	Fog computing	4 hours
Architectur application	re Harmonization Between Cloud Radio Access Ns.	Networks and Fog Networks, Fog
Need for	Fog and edge computing edge computation-Edge computing architecture SW update Geo distributed computing-concept of distributed computing concept of distributed computing concent of distributed computing concept of distributed compu	C
diagnostics (Low band	edge computation-Edge computing architectu ,SW update, Geo distributed computing-concept of o lwidth networks/ Security/ protcols),WAN vs Low b	res,Device registration, Remote cloud orchestration, Edge Networks andwidth networks.
Need for diagnostics (Low band Module 7	edge computation-Edge computing architectu ,SW update, Geo distributed computing-concept of o lwidth networks/ Security/ protcols),WAN vs Low b	res,Device registration, Remote cloud orchestration, Edge Networks andwidth networks. 3 hours
Need for diagnostics (Low band Module 7	edge computation-Edge computing architectu ,SW update, Geo distributed computing-concept of o lwidth networks/ Security/ protcols),WAN vs Low b	res,Device registration, Remote cloud orchestration, Edge Networks andwidth networks. 3 hours
Need for diagnostics (Low band Module 7	edge computation-Edge computing architectu ,SW update, Geo distributed computing-concept of o lwidth networks/ Security/ protcols),WAN vs Low b	res,Device registration, Remote cloud orchestration, Edge Networks andwidth networks. 3 hours
Need for diagnostics (Low band Module 7 Python adv	edge computation-Edge computing architectu ,SW update, Geo distributed computing-concept of o lwidth networks/ Security/ protcols),WAN vs Low b Overview of Edge Data Analytics tools ance libraries(Pandas, Scikit Learn), Tensor flow an	res,Device registration, Remote cloud orchestration, Edge Networks andwidth networks. 3 hours
Need for diagnostics (Low band Module 7 Python adv	edge computation-Edge computing architectu ,SW update, Geo distributed computing-concept of o lwidth networks/ Security/ protcols),WAN vs Low b Overview of Edge Data Analytics tools ance libraries(Pandas, Scikit Learn), Tensor flow an	res,Device registration, Remote cloud orchestration, Edge Networks andwidth networks. 3 hours
Need for diagnostics (Low band Module 7 Python adv	edge computation-Edge computing architectu ,SW update, Geo distributed computing-concept of o lwidth networks/ Security/ protcols),WAN vs Low b Overview of Edge Data Analytics tools ance libraries(Pandas, Scikit Learn), Tensor flow an Contemporary Issues Total Lecture:	res,Device registration, Remote cloud orchestration, Edge Networks andwidth networks. 3 hours d Yolo 2 hours
Need for diagnostics (Low band Module 7 Python adv Module 8 Text Books 1. Thore	edge computation-Edge computing architectu ,SW update, Geo distributed computing-concept of o lwidth networks/ Security/ protcols),WAN vs Low b Overview of Edge Data Analytics tools ance libraries(Pandas, Scikit Learn), Tensor flow an Contemporary Issues Total Lecture:	res,Device registration, Remote cloud orchestration, Edge Networks andwidth networks. 3 hours d Yolo 2 hours
Need for diagnostics (Low band Module 7 Python adv Module 8 Text Books 1. Thom Techn	edge computation-Edge computing architectu ,SW update, Geo distributed computing-concept of of lwidth networks/ Security/ protcols),WAN vs Low b Overview of Edge Data Analytics tools ance libraries(Pandas, Scikit Learn), Tensor flow an Contemporary Issues Total Lecture: s: nas Erl, Zaigham Mahmood, and Ricardo Puttini, "	res,Device registration, Remote cloud orchestration, Edge Networks andwidth networks. 3 hours d Yolo 2 hours 30 hours Cloud Computing: Concepts,

4.	Michael Missbach, Thorsten Staerk, Cam Mark Tempes, George Anderson, "SAP on			loud, Robert Madl,
5	John Mutumba Bilay, Peter Gutsche, Man	•		
	Platform Integration: The Comprehensive	Guide", Rheinv	verg publisning	$g_{1}, 2^{m}$ edition, 2019,
Refe	erence Books:			
1.	Honbo Zhou, "The Internet of Things in th 2012.	e Cloud: A Mie	ddleware Persp	ective", CRC Press,
2.	SC. Hung et al.: Architecture Harmonizat IEEE Access: The Journal for rapid open a			0
Lab	Tasks (30 Hours)			
Clou	d Platforms: Microsoft Azure/IBM Bluer	nix		
Lan	guage: Python			
1	. Pushing documents			
2	. Pushing Images and Processing			
3	. Mini Weather Station			
4	. Image analytics at cloud			
5	5. Python Scikit learn			
6	5. Tensor flow			
7	. Live video			
Reco	ommended by Board of Studies	13-09-2019		
Арри	roved by Academic Council	No. 56	Date	24-09-2019

Course code	Course Title	$ \mathbf{L} \mathbf{T} \mathbf{P} \mathbf{J} \mathbf{C} $
ECE5068	IoT Security and Trust	
Pre-Requisite:	ECE6001-Wireless Sensor Networks and IoT	Version
_	·	1.0
Objectives:		
To impart the kn	owledge and technical skills in designing secur	ed and trustable IoT systems.
Expected Outco	ome:	
At the end of the	e course students will be able to	
	plement cryptography algorithms using C prog	grams
	security problems in various networks	
	systems using elementary blocks	
	le cloud based IoT systems	
	urity problems using light weight cryptography	
6. Appreciate the	e need for cyber security laws and methods.	
Madala 1 East		5 h
	ndamentals of encryption for cyber urity.	5 hours
	Need and the Mathematical basics- History of	f anuntagraphy symmetric sinhars
	DES – AES. Public-key cryptography: RSA,	
	stems, Algebraic structure, Triple Data Encrypt	
cipher,	sems, Argeorae structure, Triple Data Enerypt	Ion Algorithm (TDEA) Block
cipiter,		
Module 2 IoT	Security framework	5 hours
	Security framework	
IIOT security fr	ame work, Security in hardware, Bootprocess,	OS & Kernel, application, run time
IIOT security fr environment and	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu	OS & Kernel, application, run time urity, Network Security: Internet,
IIOT security fr environment and	ame work, Security in hardware, Bootprocess,	OS & Kernel, application, run time urity, Network Security: Internet,
IIOT security fr environment and Intranet, LAN, V	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu Vireless Networks, Wireless cellular networks,	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP.
IIOT security fr environment and Intranet, LAN, V Module 3 Ele	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP.
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security,	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements.
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements.
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric,
IIOT security fr environment and Intranet, LAN, VModule 3Ele forVulnerability of Identity manage Device-centric aModule 4Ide	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, ementary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ement Models and Identity management in Io' nd Hybrid.	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric,
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Est	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io nd Hybrid.	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Est Trust management	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io nd Hybrid.	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment:
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Est Trust manageme Cryptosystems -	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management IoT and elementary blocks of IoT Security, ment Models and Identity management in Io' nd Hybrid. Intity Management and Trust ablishment ent lifecycle, Identity and Trust, Web of trust r - Mutual establishment phases – Comparison of	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment:
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Est Trust management	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management IoT and elementary blocks of IoT Security, ment Models and Identity management in Io' nd Hybrid. Intity Management and Trust ablishment ent lifecycle, Identity and Trust, Web of trust r - Mutual establishment phases – Comparison of	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment:
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Est Trust management Cryptosystems - management fra	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, Ementary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ement Models and Identity management in Io' nd Hybrid. Entity Management and Trust ablishment ent lifecycle, Identity and Trust, Web of trust re- Mutual establishment phases – Comparison of mework.	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment: on security analysis. Identity
IIOT security fr environment and Intranet, LAN, VModule 3Ele forVulnerability of Identity manage Device-centric aModule 4Ide EstTrust management Cryptosystems - management fraModule 5Acc	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io nd Hybrid. The security Management and Trust ablishment ent lifecycle, Identity and Trust, Web of trust no - Mutual establishment phases – Comparison of mework.	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment: on security analysis. Identity
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Trust management Cryptosystems - management fra Module 5 Acc Cryptosystems Cryptosystems	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io nd Hybrid. Intity Management and Trust ablishment ent lifecycle, Identity and Trust, Web of trust r - Mutual establishment phases – Comparison of mework. Cess Control in IoT and light weight ptography	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment: on security analysis. Identity 3 Hours
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Est Trust management Cryptosystems - management fra Module 5 Acc cry Capability-based	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io nd Hybrid. Intity Management and Trust ablishment ent lifecycle, Identity and Trust, Web of trust re- Mutual establishment phases – Comparison of mework. Cess Control in IoT and light weight ptography d access control schemes,Concepts, identity-	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment: on security analysis. Identity 3 Hours
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Est Trust management Cryptosystems - management fra Module 5 Acc cry Capability-based weight cryptogra	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io nd Hybrid. In Hybrid. Trust ablishment ent lifecycle, Identity and Trust, Web of trust r - Mutual establishment phases – Comparison of mework. Cess Control in IoT and light weight ptography d access control schemes,Concepts, identity- aphy, need and methods , IoT use cases	Arity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment: on security analysis. Identity 3 Hours based and identity-driven, Light
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Est Trust management fra Module 5 Acc Cryptosystems - management fra Module 5 Acc Module 6 Se	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io nd Hybrid. entity Management and Trust ablishment ent lifecycle, Identity and Trust, Web of trust r - Mutual establishment phases – Comparison of mework. cess Control in IoT and light weight ptography d access control schemes,Concepts, identity- aphy, need and methods , IoT use cases curity and Digital Identity in Cloud	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment: on security analysis. Identity 3 Hours based and identity-driven, Light
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Est Trust management Cryptosystems - management fra Module 5 Acc cry Capability-based weight cryptogra	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io nd Hybrid. The Management and Trust ablishment ent lifecycle, Identity and Trust, Web of trust re- Mutual establishment phases – Comparison of mework. Cress Control in IoT and light weight ptography d access control schemes,Concepts, identity- aphy, need and methods , IoT use cases curity and Digital Identity in Cloud mputing	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment: on security analysis. Identity 3 Hours based and identity-driven, Light 4 Hours
IIOT security fr environment and Intranet, LAN, V Module 3 Ele for Vulnerability of Identity manage Device-centric a Module 4 Ide Est Trust management Cryptosystems - management fra Module 5 Acc cry Capability-based weight cryptogra Module 6 Se Con Cloud security ,	ame work, Security in hardware,Bootprocess, d containers. Need and methods of Edge Secu- Vireless Networks, Wireless cellular networks, mentary blocks of IoT Security & Models Identity Management ToT and elementary blocks of IoT Security, ment Models and Identity management in Io nd Hybrid. entity Management and Trust ablishment ent lifecycle, Identity and Trust, Web of trust r - Mutual establishment phases – Comparison of mework. cess Control in IoT and light weight ptography d access control schemes,Concepts, identity- aphy, need and methods , IoT use cases curity and Digital Identity in Cloud	OS & Kernel, application,run time urity, Network Security: Internet, Cellular Networks and VOIP. 4 Hours Threat modeling – Key elements. T, Approaches using User-centric, 4 Hours models. Establishment: on security analysis. Identity 3 Hours based and identity-driven, Light 4 Hours

Mo	odule 7	Cyber Crimes, Hackers and Fore	nsics			3 Hours
Cy	ber Crim	es and Laws – Hackers – Dealing with	n the rise tide	of Cyb	er Crim	es – Cyber Forensics
and	l inciden	t Response – Network Forensics.		·		•
Mo	odule:8	Contemporary Issues				2 Hours
		Το	tal Lecture:	30	Hours	
Te	xt Books	:				
1.	John R	Vacca, "Computer and Information S	Security Hand	book",	Elsevie	r, 2013.
	Pariksh	it Narendra Mahalle , Poonam N. Rai	lkar, "Identity	/ Mana	agement	for Internet of
	Things	', River Publishers, 2015.				
2.		n Stallings, "Cryptography and Net	work securit	y: Pri	nciples	and Practice", 5th
		, 2014, Pearson Education, India.				
3.	Maryli	ne Laurent, Samia Bouzefrane, "Digita	al Identity Ma	nagem	ent", Els	sevier, 2015.
4.	-	Migga Kizza, "Computer Network Se	curity", Sprin	ger, 20)05.	
Re	ference]					
1.		f Paar and Jan Pelzl, "Understanding	g Cryptograph	ny – A	Textbo	ok for Students and
		oners", Springer, 2014.				
2.		z A.Forouzan : Cryptography & Ne	twork Securit	ty – T	The McC	Graw Hill Company,
	2007.					
3.	Charlie		ike Specine		etwork	2
		inication in a public World", PTR Pre				2002.
4.		r Gilchrist, "IoT security Issues", Ore	illy publicatio	ons, 20	17.	
Ty	A	t of Projects(not limited to)				
		t weight cryptography				
		id block ciphers.				
		yption using applets				
		al signatures				
		ew of Trust in IoT transactions.				
		t analysis				
		d security				
		management in clouds				
		ded by Board of Studies	13-09-2019			
Ap	proved l	oy Academic Council	No. 56	Da	ate	24-09-2019

Course code		Course Title		L T P J C
ECE5069		IoT Applications and Web deve	lopment	$\begin{array}{c c c c c c c c c c c c c c c c c c c $
Pre-requisite	•	ECE5061-IoT fundamentals and Archit		Syllabus version
•				v. 1.00
Course Obje	ctives			
1. To acquire	specif	ic scripting knowledge to develop interact	ive applications.	
2. To understa	and the	e basics of android application development	nt.	
3. To apply th	ne prog	gramming skills in developing application	pertaining to Indu	strial, medical,
agricultural, e	etc.			
		Dutcome: Students will be able to		
•••		web forms to acquire and process user & s		
		using Java Script with a focus on internet	of things	
		e application using android SDK		
		r smart systems in a distributed environme oT architecture and building blocks for var		
		plinary case to case modelling and execute		nlication
0. Devise mui	luuise	prinary case to case moderning and execute	e while range of a	opiication
5 Having des	ion th	inking capability		
		ional thinking (Ability to translate vast dat	a in to abstract co	oncepts and to
understand da				
		ligital footprint		
	-	ip Language		3 hours
		rkup language, HTML document structur	e. HTML forms.	
		sheets, DHTML, Tools for image creation		
		ment using charts	I	, I
		ing Language		4 hours
		Script, Functions, DOM, Forms, and Eve	nt Handlers, Obje	ect Handlers, Input
		pplication design using J2ME, IoT develo	pment using Rea	l time rules,
platforms, ale	erts			
Madula 2	Andra	aid Drograming Framework		5 hours
		oid Programing Framework	ant Simple III I	5 hours
11		pment: Android Development environmeters, Event Driven Programming, opening	· •	
properties, Ot	0100j	eets, Event Driven i rogramming, opening	and closing a Dat	labase
Module:4 I	Indus	trial Internet Application		4 hours
		and Components, Industrial Manufacturing	Monitoring Co	
		oduction to Hadoop and big data analytics		inition, optimization
	<u>,</u>			
Module:5	Appli	cations in agriculture		3 hours
		ather monitoring, Precision farming, Smar	t Greenhouse, Dr	
	0	<u> </u>	,	1.
Module:6	Appli	cations in IoT enabled Smart		4 hours
	Cities			
Energy Consu	umptic	n Monitoring, Smart Energy Meters, Hom	e automation, Sm	art Grid and
		sting, Intelligent Parking, Data lake servic		
Module:7 I	Healt	hcare applications		5 hours

Architecture of IoT for Healthcare, Multiple views coalescence, SBC-ADL to construct the system architecture. Use Cases : Wearable devices for Remote monitoring of Physiological parameter, ECG, EEG, Diabetes and Blood Pressure.

Module:8 Contemporary issues: 2 how Total Lecture hours: 30 hours 1000000000000000000000000000000000000
Text Book(s) 1. John Dean, Web Programming with HTML5, CSS and JavaScript, 2018, Jones and Bartlett Publishers Inc., ISBN-10: 9781284091793 2. DiMarzio J. F., Beginning Android Programming with Android Studio, 2016, 4 th ed., Wiley, ISBN-10: 9788126565580 Reference Books 1. Fadi Al-Turjman, Intelligence in IoT- enabled Smart Cities, 2019, 1 st edition, CRC Predistry ISBN-10: 1138316849 2. Giacomo Veneri, and Antonio Capasso, Hands-on Industrial Internet of Things: Created powerful industrial IoT infrastructure using Industry 4.0, 2018, Packt Publishing. 3. Subhas Chandra Mukhopadhyay, Smart Sensing Technology for Agriculture a Environmental Monitoring, 2012, Springer, ISBN-10: 3642276377 4. Mode of Evaluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Challenging Experiments (Indicative) 1. Design and development of wireless video surveillance robot
Text Book(s) 1. John Dean, Web Programming with HTML5, CSS and JavaScript, 2018, Jones and Bartlett Publishers Inc., ISBN-10: 9781284091793 2. DiMarzio J. F., Beginning Android Programming with Android Studio, 2016, 4 th ed., Wiley, ISBN-10: 9788126565580 Reference Books 1. Fadi Al-Turjman, Intelligence in IoT- enabled Smart Cities, 2019, 1 st edition, CRC Prest ISBN-10: 1138316849 2. Giacomo Veneri, and Antonio Capasso, Hands-on Industrial Internet of Things: Create powerful industrial IoT infrastructure using Industry 4.0, 2018, Packt Publishing. 3. Subhas Chandra Mukhopadhyay, Smart Sensing Technology for Agriculture a Environmental Monitoring, 2012, Springer, ISBN-10: 3642276377 4. Mode of Evaluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Challenging Experiments (Indicative) 1. Design and development of wireless video surveillance robot 15 hours
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3. Subhas Chandra Mukhopadhyay, Smart Sensing Technology for Agriculture a Environmental Monitoring, 2012, Springer, ISBN-10: 3642276377 4. Mode of Evaluation: CAT / Assignment / Quiz / FAT / Project / Seminar List of Challenging Experiments (Indicative) 1 1. Design and development of wireless video surveillance robot 15 hours
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1.Design and development of wireless video surveillance robot15 hours
2. Design and implementation of wearship glove to anable sign to speech
2. Design and implementation of wearable glove to enable sign to speech conversation
3. IoT based home automation with security features
4. Smart farming : IoT based system for smart agriculture
5. IoT application to improvise industrial automation
6. Smart Energy meters to minimize power consumptions with a statistical approach
7. Bringing intelligence body area network – Smart Healthcare systems
Mode of assessment: Mid CAT, FAT
Recommended by Board of Studies 13-09-2019
Approved by Academic CouncilNo. 56Date24-09-2019

Course code	Course title	L	Т	P	J	С
ECE6003	MICROSYSTEMS AND HYBRID TECHNOLOG	Y 2	0	2	0	3
Prerequisite	ECE5001 Principles of Sensors	S	yllab	us v	versi	ion
^			•	1.1		
Course Objective	s:	I				
1. To introduce	e the fundamental concepts of MEMS based sensors and actua	ors.				
	the students with various materials and material properties for					ng.
	comprehensive understanding of various micromachining techr	iques a	nd ex	pos	e the	
	lesign, simulation and analysis software.					
4. Enhancing t	he basics of thick film and hybrid technologies for sensor deve	opmen	t.			
E 4 1 C	0.4					
Expected Course		10 1	24			
	understand the fundamental concepts and background of MEI h the basics of various sensors and actuators.	AS and	Micr	osys	stems	5
	s were acquainted with various materials for Microsystem desig	ning				
	nd compare the scaling effects in miniaturizing devices.	,iiiig.				
	and interpret various micromachining techniques and design, a	nalysis	and	appl	licatio	ons
	IEMS devices micromachining tools and techniques	•		••		
	with thick film and hybrid technologies for sensor developmen					
7. Incorporate	simulation and micro-fabrication knowledge for developing va	rious M	IEMS	dev	vices.	
					<u></u>	
	oduction to MEMS and Microsystems				<u>3 ho</u>	
	osystems, Miniaturization, Benefits of Microsystems,	Typic	al M	IEN	IS a	nd
Microsystems proc	ducts, Evolution of Micro fabrication and Applications.					
Modulo:2 Intro	oduction to Sensors and Actuators				3 ho	IIWG
	and classification of transducers: electrostatic, piezoelec	stria t	horm			
	static, resistive, chemical etc. SAW devices. Micro actua					
	agineering Science for Microsystem design and fabrication		Jesig	n o	1 10110	ciu
	is moorning before of the toby storm design and rabitedion					
Module:3 Mate	erials for Microsystems				4 ho	urs
	ompounds, Silicon Piezo resistors, Gallium Arsenide,	Ouartz	z. Pi			
	s, Shape Memory Alloys, ferroelectric and rheological ma					
Module:4 Scali	ng Effects in Microsystems				4 ho	urs
Introduction to Se	caling, Scaling laws, Scaling in Geometry, Scaling in	Rigid	body	dy	nami	ics,
	nagnetic, Electrostatic, magnetic, optical and Thermal do	0				
mechanics.				-		
Module:5 Micr	omachining Technologies				4 ho	urs
	on processes techniques, Photolithography, Ion Implan					
	Deposition, Physical vapor Deposition, Epitaxy, Etching,	Bulk n	nicro	mac	chini	ng,
Surface Micromac	hining, LIGA and other techniques.					
					4.3	
	AS and micro systems applications		6		4 ho	
	tion in actual systems, introduction to RF- MEMS, MC			re o	of sm	nart
structures and ME	MS leading to NEMS. Packaging, test and calibration of N	IEMS	•			

Mo	odule:7 Hybrid Technology	2 hours
Thi	ick-film and hybrid technology in sensor production. Basic mate	erials, components,
	nufacturing Screen manufacturing, Screen printing, Parameters, Comparis	
	n technology Structure dimensions, Assembly and packaging Surface moun	
	tive and passive devices (SMD), Connection technologies, Packaging.	
Mo	dule:8 Contemporary issues:	2 hours
	Total Lecture hours: 30 hours	
Тез	xt Book(s)	
1.	G.K.Ananthasuresh, K J Vinoy, S Gopalakrishnan, KN Bhatt, V K Aatro	- " Micro and smar
1.	systems", 2012, 1 st ed., Wiley, New York.	c, where and smart
2.	Tai-Ran Hsu, "MEMS & Microsystem, Design and Manufacture", 2017, 1	st ed McGraw Hill
2.	India, New Delhi.	
Ref	ference Books	
1.	Mahalick NP, "MEMS", 2017, 1 st ed., Tata McGraw Hill, New Delhi	
2	Wolfgang Menz, Jürgen Mohr, Oliver Paul, "Microsystem Technology", 2	2011. 2 nd ed., Wilev
-	New York.	
3	Banks H.T. Smith R.C. and Wang Y.Smart, 'Material Structures - Model	ing. Estimation and
-	Control', 2011, 1 st ed., John Wiley & Sons, NewYork.	8,
4	Massood Tabib – Arar, 'Microactuators – Electrical, Magnetic Thermal, C	ptical, Mechanical,
	Chemical and Smart structures', 2014, 1 st ed., Kluwer Academic publisher	s, New York .
Mo	de of Evaluation: CAT / Assignment / Quiz / FAT / Project / Seminar	, ,
T ia	t of Chollonging Europimonts (Indicative)	
	t of Challenging Experiments (Indicative) Design and Simulation of MEMS Capacitance based Accelerometer:	15 hours
1.	Design and Simulation of MEMS Capacitance based Accelerometer.	15 hours
	In this topic, you need to design a capacitive accelerometer that has a fu	.11
	scale Measurement range of ± 10 g. The accelerometer may be design	
	using a closed loop or an open-loop. You need to have reasonable over rar	
	protection in your device.	ige
	Specification:	
	Measurement range: ± 10g	
	Output capacitance: at least tens of fF level	
	Device simulation results (must take into account parasitic capacitance of	
	your design):	
	(a) Static analyses:	
	Gap vs. acceleration	
	Capacitance (or differential capacitance) vs. acceleration	
	(identify sensitivity [F/g])	
	(identify sensitivity [F/g]) (b) Dynamic analyses:	
2.	(identify sensitivity [F/g])(b) Dynamic analyses: Your device's response on vibration.	15 hours
2.	 (identify sensitivity [F/g]) (b) Dynamic analyses: Your device's response on vibration. Piezoresistive barometric pressure sensor: 	15 hours
2.	(identify sensitivity [F/g])(b) Dynamic analyses: Your device's response on vibration.	the

Specification:						
Measurement range: 0 -1.1 bar.						
Device simulation results:						
(i) Strain in the piezoresistor vs.	pressure					
(ii) Resistance vs. pressure						
(iii) Voltage output vs. pressure	(iii) Voltage output vs. pressure for Wheatstone bridge circuit output.					
Circuit integration issues:						
Temperature compensation circ	uit design					
	Total Laboratory Hours					
Mode of assessment: Continuous Asses						
Recommended by Board of Studies						
Approved by Academic Council	No. 47	Date	05-10-2017			

Course code		Course title		L	T	P	J	<u>C</u>
ECE6004		RF AND MICROWAVE SEN	NSORS	3	0	0	0	3
Prerequisite:	5	ECE5001-Principles of Sensors		Syl	llab	us v	ersi	on
						1.0		
Course Obje								
		e the students with different RF and Micro	,					
		ize antenna design with a good understa	inding of their para	met	ters	and		
applic								
		e comprehensive knowledge of wearable a						
4. To exp	piore a	and understand basics of RFID technology	/.					
Expected Co	urse (Dutcome:						
		per antenna design to be used in the RF sp	bectral region					
		fic radiation pattern and evaluate them in						
		e principle behind different radar system		riou	us a	ppli	catio	on
		e radar systems.						
		asic knowledge in the measurement of RF	radiation.					
5. Gain k	knowl	edge about the RFID technology.						
Module:1							1	
		ngarg				6		ır
Microwave A		nsors	damental paramete	ore	of	-	ho	
	Antenr	a-Introduction, types of Antenna, fun				ant	enna	ıs,
radiation mec	Antenr	a-Introduction, types of Antenna, fun m, Fresnel and Fraunhofer regions. Anter				ant	enna	as
radiation mec	Antenr	a-Introduction, types of Antenna, fun m, Fresnel and Fraunhofer regions. Anter				ant	enna	as
radiation mec for sensing, ra	Antenr chanis adiom	na-Introduction, types of Antenna, fun m, Fresnel and Fraunhofer regions. Anter eter and radar				ant nd A	enna	is in
radiation mec for sensing, ra Module:2	Antenr chanis adiom Anten	na-Introduction, types of Antenna, fun m, Fresnel and Fraunhofer regions. Anter eter and radar na for personal area communication.	nna for communica	atio	n an	ant nd A	enna Inter	as in ir
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radiation mec for sensing, ra Module:2 A Concepts of Devices, Des	Antenri chanis adiom Anten Printe ign R	na-Introduction, types of Antenna, fun m, Fresnel and Fraunhofer regions. Anter eter and radar na for personal area communication.	nna for communica	ntion nas	n an	ant nd A 5 r W	enna Inter ho u eara WBA	as in ur bl
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radiation mec for sensing, radiationModule:2AConcepts of Devices, Des Radio Channe on the HumarModule:3I	Antenr chanis: adiom Anten Printe ign R el Cha n Body Radar	na-Introduction, types of Antenna, fun m, Fresnel and Fraunhofer regions. Anter eter and radar na for personal area communication. d Antennas, Broadband Microstrip Patc equirements, Modeling and Characteriza racterization and Effect of Wearable Ante y, Compact Wearable Antenna for differer	nna for communica h Antennas, Anten ation of Wearable A ennas, Domains of C nt applications.	ation nas Ante Open	n an foi enna ratic	ant ad A 5 5 7 W as, V on, S	enna inter ho u eara WBA Source	in in in bl ir bl
radiation mec for sensing, ra Module:2 A Concepts of Devices, Des Radio Channe on the Humar Module:3 I Introduction	Antenre chanise adiom Anten Printe ign R el Cha n Body Radar to RA	na-Introduction, types of Antenna, fun m, Fresnel and Fraunhofer regions. Anter- eter and radar na for personal area communication. d Antennas, Broadband Microstrip Patc equirements, Modeling and Characteriza racterization and Effect of Wearable Anter y, Compact Wearable Antenna for differer DAR, RADAR range equation, MTI an	nna for communica h Antennas, Anten ation of Wearable A ennas, Domains of C nt applications.	ation nas Ante Open	n an foi enna ratic	ant ad A 5 5 7 W as, V on, S	enna inter ho u eara WBA Source	as, in: ur bl AN ce
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Mo	dule:7	RFID Sensors				8 hours
Intr	oduction	, Components of RFID sys	stems, hardware ar	nd softw	ware compone	ents, RFID standards,
RF	ID applic	cations.				
Mo	dule:8	Contemporary issues:				2 hours
			Total Lecture ho	ours:	45 hours	
Tex	kt Book(<i></i>				
1.	Finken	zeuer Klaus, "RFID Handbo	ook", 2011, 3 rd edi	tion, Jo	ohn Wiley and	l Sons, New Jersey.
2.	Consta	ntine A. Balanis, "Antenn	a Theory Analysi	is and	Design", 201	16, 4 th edition, John
	Wiley a	and Sons, New Jersey.				
Ref	ference l	Books				
1.	B. Hoff	fman - Wellenhof, H.Lichte	negger and J.Colli	ns, "G	PS: Theory an	d Practice ", 5 th
	edition,	, Springer, New York, 2012				
2	Lillesa	nd & Kiefer, "Remote Se	nsing and Image	Interp	retation", 201	1, 6 th edition, John
	Wiley a	and Sons, New Jersey.				
Mo	de of Ev	aluation: CAT / Assignmen	nt / Quiz / FAT / Pr	roject /	Seminar	
Rec	comment	led by Board of Studies	28.01.2017			
App	proved b	y Academic Council	No. 47	Date	05-10-20	17

Course code	Course title BIOMEDICAL SENSORS	L 2	T	P 2	J 0	$\frac{C}{3}$
ECE6007			0			
Prerequisite:	ECE5001-Principles of Sensors	Sy	llab	<u>us v</u> 1.1	versi	on
Course Objective				1.1		
	he students to different types of electrodes used in bio po	tantial r	acor	dina		
	te the students in recognizing electrode configuration and					the
	elative motions.	1 155005	iciat	cu v	viui	.110
	the students to perceive the need for bio amplifiers a	nd their	· cha	ract	erist	ic
	be design for various bandwidth and frequency response.	ing then	ene	iiuot	01150	
	e cardiac, respiratory and muscular physiological system truments used to acquire signals from living systems.	ns. Study	the	des	igns	0
	m the conception in detection of chemical and biomolecu	les.				
	vill be expedient in applying specific radiology metho		liagi	iosti	ics a	n
analysis.			υ			
-	ts also understand the theory behind the sound and tissue	interact	ion,	and	able	t
apply in the	erapeutic application.					
Expected Course	Outcome:					
	e need for reusable electrodes and understands the method	1				
	miliar with electrode placements for various biopotenti	al recor	ding	as	per	th
voltage ran	•					
-	f understanding the design principles of bio-amplifiers	and dr	awb	ack	rela	ie
with noises						
	veldge for implementing different types of physiological provide a sensor	paramete	er m	easu	rem	en
0 11	opriate sensors. iscuss, develop and apply site specific chemical senso	ra docio	n or	d i	mag	n
	for typical issues	is desig	, ii ai	iu ii	mag	пş
	disseminate the design knowledge in analyzing in-vivo ailmen	ts				
u. 10						
_						
Module:1 Biop	otential Electrodes			3	3 ho	ır
	otential and its propagation. Electrode-electrolyte in	terface,	ele	ctro	de-s	ki
	Il potential, impedance, polarization effects of elect					
electrodes. Types	of electrodes - surface, needle and micro electrodes and t	heir equ	ivale	ent c	ircu	its
Recording problem	ns - measurement with two electrodes.					
				3	3 ho	ır
Module:2 EEG	, EMG & ECG					
	,	oven's tr	iang		tand	ar
Bio signal charact	eristics – frequency and amplitude ranges. ECG – Eintho			le, s		
Bio signal character 12 lead system. I	,	average	e mo	le, s de.	EM	G
Bio signal charact 12 lead system. I unipolar and bipo	eristics – frequency and amplitude ranges. $ECG - Einthold EEG - 10-20$ electrode system, unipolar, bipolar and	average	e mo	le, s de.	EM	G
Bio signal character 12 lead system. I unipolar and bipo EMG- procedure a	eristics – frequency and amplitude ranges. ECG – Eintho EEG – 10-20 electrode system, unipolar, bipolar and lar mode. EEG- procedure, signal artefacts, signal anal	average	e mo	le, s ode. d po	EM	G- al
Bio signal character 12 lead system. I unipolar and bipo EMG- procedure a Module:3 Bio A	eristics – frequency and amplitude ranges. ECG – Eintho EEG – 10-20 electrode system, unipolar, bipolar and lar mode. EEG- procedure, signal artefacts, signal anal and signal analysis, Nerve conduction study	average lysis, ev	e mo vokeo	le, s ode. d po	EM otent	G al

isolated D	C amplifier and AC carrier amplifier. Chopper ampl	ifier. Power lir	e interference
Module:4	Physical Sensors in Biomedicine		8 hours
measureme blood pres pressure pu flow measu	e measurement: core temperature,-surface ten nt: skin blood- hot film anemometer- Doppler sor sure measurement: noninvasive- hemodynamic lses and movement- ocular pressure sensor- acous rement, sensors for bio-magnetism, tactile sensors f copy, artificial retina.	nography- elec invasive. Spire tic sensors in l	asive. Blood flow tromagnetic sensor ometry- sensors for nearing aid, in blood
Module:5	Sensors for Chemical Quantities in Biomedicine		3 hours
	and pH sensor, electrochemical sensor, transcuta er, optical oximetry, pulseoximetry, earoximetry.	neous, optical	fiber sensor, mass
Module:6	Detectors in Radiology		4 hours
X ray imag	ing with sensors, detectors in nuclear radiology, m sonance imaging.	agnetic field s	
Module:7	Sound in Medicine		4 hours
	of Ultrasound with matter; Cavitations, Reflection, Iltrasound- Doppler-Double Doppler shift-Clinical		Scanning systems –
Module:8	Contemporary issues:		2 hours
	Total Lecture hours:	30 hours	
Text Book			
& Son	Vebster, J. G. Webster, "Medical Instrumentation; A s, Inc., New York, 4 th Edition, 2015	pplication and	Design", John Wiley
Reference			
3 rd edit	pur R.S, "Handbook of Biomedical Instrumentatio ion ,2014.	-	
2 John E	nderle, Joseph Bronzino, "Introduction to Biomedi tion, 2011.		
		11 1 1 1 1	1 T T 1 T
3 Myer	Kutz, "Biomedical Engineering and Design Ha dical Engineering Fundamentals", McGraw Hill Pul		
3 Myer Biome	Kutz, "Biomedical Engineering and Design Ha dical Engineering Fundamentals", McGraw Hill Pul aluation: CAT / Assignment / Quiz / FAT / Project	olisher, USA, 2	
3 Myer Biome Mode of Ev	dical Engineering Fundamentals", McGraw Hill Pul aluation: CAT / Assignment / Quiz / FAT / Project	olisher, USA, 2	
 3 Myer Biome Mode of Ev List of Cha 1. Pulse of saturatian a circuant a circuant activity normatiant 	dical Engineering Fundamentals", McGraw Hill Pul	olisher, USA, 2 / Seminar everyone's oxy condition. Des leasurement in considered to condition using	rgen 6 hours sign the be g an

	stored and processed. Modify the DC offset cancellation and driven voltage due to interference and s	-right leg circuit t	o reduce c	ommon-mode		
	Also, include a low-pass filter that	0 1		0 0		
3	Impedance plethysmography is a volumes in the body, based on the body surface. Determine the cha volume which in turn changes the the volume conductor. Measure a system.	method of deter measurement of e inge in the condu- e distribution of the	mining ch electric imp ctivity du he introdu	pedance at the e to the flow ced current in	6 hours	
4						
5.	Design a method to analysis liqui measurement technique(Laser/Ultr velocity using LabView	6 hours				
			Total Lab	oratory Hours	30 hours	
Mo	de of assessment: Continuous Asses	ssment and FAT		<u> </u>		
	commended by Board of Studies	28.01.2017				
Ap	proved by Academic Council	No. 47	Date	05-10-2017		

Course Code	Course Title	L	Т	P	J	C	
ECE6087	Multi-disciplinary Product Development	3	0	0	4	4	
Prerequisite:	Nil	Syllabus Version				on	
				1.0			
Course Object	ives:						
1. To develop	the students for integrative thinking on good engineering pract	ices.					
2. To emphasis the students from shifting their mindset from theoretical to practical multi-						ılti-	
disciplinary	skills through installing the know-how of actual practice in inc	lustr	y fie	ld.			
Expected Outc	omes:						
The student wil	l be able						
and knowle	trate an understanding of the overview of all the product devide of concept generation and selection tools	velop	omer	ıt pr	oces	ses	
	2. To value the voice of the customer in getting the feedback						
	rate an understanding of quality in a product or service through		ls.				
4. To improve	the design of the product in accordance with the quality standa	ırds					

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- 5. To apply various strategies of designing experiments, methods to uphold the status of six sigma and improve the reliability of a product.
- 6. Strive towards efficient manufacturing process by systematic resource procurement
- 7. Analyze and demonstrate knowledge in product development

Module:1	Customer Value and Market Segmentation	6 hours
	_	
•	measure value by what a customer is willing to	
-	ction requirement development. No product can sat	-
Segmentati	on shows the methodology to target a specific custor	mer group for product positioning.
Module:2	Voice of customer	6 hours
Voice of cu	stomer: A disciplined approach to directly collecti	ng feedback and input from
customers.	Used throughout the Engineering and Marketing pro	ocess.
Module:3	Quality Function deployment	6 hours
Critical to	Quality and Quality function Deployment: Specify	and quantify customer needs. Flow
down those	customer needs in each step of product developmer	it.
down those	customer needs in each step of product developmer	11.
down those Module:4	Design of Six Sigma	nt. 6 hours
Module:4	<u> </u>	6 hours
Module:4 Integrate st	Design of Six Sigma atistics into quality continuous improvement opera	6 hours ation model. Design for Six Sigma
Module:4 Integrate st	Design of Six Sigma atistics into quality continuous improvement opera shout the product development process in order to	6 hours ation model. Design for Six Sigma
Module:4 Integrate st used throug	Design of Six Sigma atistics into quality continuous improvement opera shout the product development process in order to	6 hours ation model. Design for Six Sigma
Module:4 Integrate st used throug	Design of Six Sigma atistics into quality continuous improvement opera shout the product development process in order to	6 hours ation model. Design for Six Sigma
Module:4 Integrate st used throug design deliv Module:5	Design of Six Sigma atistics into quality continuous improvement operation shout the product development process in order to very.	6 hours ation model. Design for Six Sigma improve the correction of the first 6 hours

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IVIC	odule:6	Design of Manufacturing					61	hours
De	sign of N	Anufacturing: Consider product manu	ıfacturability	durir	ng design	phase	. Manufa	octure
pro	oduct effi	ciently increases the organization comp	petitive powe	er.				
Mo	odule:7	Strategic sourcing and e-sourcing					7 I	hours
Str	ategic So	ourcing and Standardized Parts: Levera	ge the exper	tise o	f externa	l sourc	e is one o	of the
key	y strategi	es to success. Parts standardization imp	proves the m	anufa	cturing fl	lexibili	ty and re	duces
the	quality i	ssue. e-sourcing: Leverage web-based	applications	to del	iver savi	ngs and	d product	ivity
gai	ns while	conducting the strategic sourcing.						
Mo	odule:8	Contemporary Issues					2 hours	S
		Tot	al Lecture:	30	hours			
То	vt Books		al Lecture:	30	hours			
	xt Books	:				r 1 st ed	lition 20	14
Te : 1.						r, 1 st ed	lition, 20	14
	Tempe	:	turing and D	esign	, Elsevier			
1.	Tempe Art We Techno	: Iman, <u>Shercliff</u> , <u>Van Eyben</u> , "Manufac einstein, "Handbook of Market Segm logy Firms, Third Edition (Haworth S	turing and D entation: Str Series in Seg	esign rategic mente	, Elsevier	ng for	Business	s and
1. 2.	Tempe Art We Techno Market	: Iman, <u>Shercliff</u> , <u>Van Eyben</u> , "Manufac einstein, "Handbook of Market Segm logy Firms, Third Edition (Haworth S), 3 rd ed. Routledge, Taylor and Francis	turing and D entation: Str series in Seg s group, 2004	esign ategic mente	, Elsevier e Targeti ed, Targe	ng for ted, an	Business d Custor	s and nized
1.	TempeArt WoTechnoMarketMichae	: Iman, <u>Shercliff</u> , <u>Van Eyben</u> , "Manufac einstein, "Handbook of Market Segm logy Firms, Third Edition (Haworth S), 3 rd ed. Routledge, Taylor and Francis d Lamoureux, "The e-Sourcing Hand	turing and D entation: Str series in Seg s group, 2004	esign ategic mente	, Elsevier e Targeti ed, Targe	ng for ted, an	Business d Custor	s and nized
1. 2.	TempeArt WoTechnoMarketMichae	: Iman, <u>Shercliff</u> , <u>Van Eyben</u> , "Manufac einstein, "Handbook of Market Segm logy Firms, Third Edition (Haworth S), 3 rd ed. Routledge, Taylor and Francis	turing and D entation: Str series in Seg s group, 2004	esign ategic mente	, Elsevier e Targeti ed, Targe	ng for ted, an	Business d Custor	s and nized
1. 2. 3.	Tempe Art Wa Techno Market Michae Manag	: Iman, <u>Shercliff</u> , <u>Van Eyben</u> , "Manufac einstein, "Handbook of Market Segm logy Firms, Third Edition (Haworth S), 3 rd ed. Routledge, Taylor and Francis I Lamoureux, "The e-Sourcing Hand ement Success, Lasta publishing, 2008	turing and D entation: Str Series in Seg s group, 2004 book: A Mo	esign ategic mente	, Elsevier e Targeti ed, Targe	ng for ted, an	Business d Custor	s and nized
1. 2. 3. Mo	TempeArt WeTechnoMarketMichaeManagode of Ev	: Iman, <u>Shercliff</u> , <u>Van Eyben</u> , "Manufac einstein, "Handbook of Market Segm logy Firms, Third Edition (Haworth S), 3 rd ed. Routledge, Taylor and Francis I Lamoureux, "The e-Sourcing Hand ement Success, Lasta publishing, 2008 aluation:Continuous Assessment and F	turing and D entation: Str Series in Seg s group, 2004 book: A Mo	esign ategic mente	, Elsevier e Targeti ed, Targe	ng for ted, an	Business d Custor	s and nized
1. 2. 3. Mo	TempeArt WeTechnoMarketMichaeManagode of Ev	: Iman, <u>Shercliff</u> , <u>Van Eyben</u> , "Manufac einstein, "Handbook of Market Segm logy Firms, Third Edition (Haworth S), 3 rd ed. Routledge, Taylor and Francis I Lamoureux, "The e-Sourcing Hand ement Success, Lasta publishing, 2008 aluation:Continuous Assessment and F	turing and D entation: Str Series in Seg s group, 2004 book: A Mo	esign ategic mente	, Elsevier e Targeti ed, Targe	ng for ted, an	Business d Custor	s and nized

Course Code	Course Title	L	Т	P	J	С
ECE6088	DEEP LEARNING - AN APPROACH TO	3	0	0	0	3
	ARTIFICIAL INTELLIGENCE					
Prerequisite:	Nil	S	yllab	us V	'ersi	on
						1.0
Course Objectives:						
intelligence2. To provide a their application3. To explore the networks.	the fundamental theory and concepts of machine learning comprehensive foundation to artificial neural networks, ons to pattern recognition. The learning paradigms of supervised and unsupervised shall posure to the recent advances in the field of and facilitat	neur low/d	o-mo eep 1	delin neura	ng, a	
-	quate knowledge on deep learning frameworks and their a	applic	ation	s to	solv	ing
Course Outcomes:						
 supervised and 3. Develop and the 4. Understand the successful mach 5. Identify the de appropriate for 	e differences between shallow neural networks and dee d unsupervised learning. rain neural networks for classification, regression and cluss foundations of neural networks, how to build neural networks a nine learning projects eep feed forward, convolution and recurrent neural network r various types of learning tasks in various domains ep learning algorithm and solve real world problems	tering and lear	rn ho	w to	lead	
Module:1 Foundat	ions of Machine Learning-I				5 ho	irc
Supervised and unsup classification and reginner-parametric classif	pervised learning, parametric vs non-parametric models,			mo	lels	for
Modulo 7 Founda	ression- Linear Regression, Logistic Regression, Naïve B fier-K-nearest neighbour, support vector machines.			5	how	
	fier-K-nearest neighbour, support vector machines. tions of Machine Learning-II	volida	tion		hou	rs
Clustering- distance l cross validations, feat	fier-K-nearest neighbour, support vector machines.			tech	niqu	rs es-
Clustering- distance l cross validations, feat values, Eigen vectors,	fier-K-nearest neighbour,support vector machines. tions of Machine Learning-II based- K-means, density based, association rule mining, ure selection and dimensionality reduction, principal com			tech alysi	niqu	rs es- gen

Module:4	Deep Feed Forward Neural Networks	6 hours

Feed forward neural networks- deep model- output units and hidden units, training deep modelshyper parameters and validation sets-cross validation, capacity, overfitting and under fitting, bias vs variance trade off, cross validation - vanishing gradient problem, new optimization methods (adagrad, adadelta, rmsprop, adam), regularization methods (dropout, batch normalization, dataset augmentation), early stopping.

Module:5 Convolutional Neural Networks

7 hours

Convolution operation- kernel and feature map, sparse connectivity, equivariance through parameter sharing, pooling function for invariant representation, convolution and pooling as strong prior, convolution with stride, effect of zero padding, single-channel and multi-channel data types used in ConvNet, variants of basic convolution- locally connected, tiled ConvNet- spatial separable and depthwise separable convolutions, fully connected layers, ConvNet architecture- layer patterns, layer sizing parameters, case studies- LeNet, AlexNet

Module:6Recurrent Neural Networks6 hoursSequence learning with neural nets, unrolling the recurrence, training RNN- Backpropagation through
time (BPTT), vanishing gradient problem, Gated recurrent unit (GRU), Long short term memory
(LSTM), Bidirectional LSTMs, bidirectional RNNs

Module:7Deep Learning Tools and Applications8 hoursTools:TensorFlow, Keras, PyTorch, Caffe, Theano,
RCNN - YOLO, SSD. Speech recognition with RNN.MXNet. Applications: Object detection with

Module:8 Contemporary Issues

2 hours

		Total	Lecture: 45 hours	
Text Book	x (s)			
1.	Bengio, Yoshua, Ian J. Goodfello Press	w, and Aaron C	Courville. "Deep lear	ning" 2015, MIT
2.	Josh Patterson and Adam Gibso O'Reilly Media Inc., 2017, USA.	n, "Deep Learr	ing- A Practitioner	's Approach"
Reference	Book(s)			
1.	Bishop, C. ,M., Pattern Recognitio	n and Machine I	earning, Springer, 20)11
2.	Rich E and Knight K, "Artificial Ir	ntelligence", 201	1, 2 nd ed., TMH, New	v Delhi,
3.	Bengio, Yoshua. "Learning deep Machine Learning, 2(1)- 2009	architectures for	or AI- Foundations a	and trends in
4.	Tom M. Mitchell, "Machine Learn	ing", McGraw-H	Hill Education (India)	Pvt Ltd, 2013.
	Evaluation: CAT, Digital Assignment /Makeathon and FAT.	nts, Quiz, Onlin	e course, Paper publ	lication, Projects,
Recommen	nded by Board of Studies	26-04-2019		
Approved	by Academic Council	No. 55	Date: 13-06-2019	

Course Code	Course Title		L	Т	P	J	C	
ECE6089	AUTOMOTIVE SENSORS AND IN-V NETWORKING	EHICLE	2	0	2	0	3	
Pre-requisite	ECE5060- Principles of Sensors and Signal	Conditioning	Sv	llah	lis v	ersi	010	
Tre-requisite	ECESODO-T fincipies of Sensors and Signal	Conditioning	Syllabus version 1.00					
Course Object	ives:							
v	t with the basic automotive parts and the need	for sensor inte	grat	ion	in d	iffer	ent	
	ive systems		0					
2. Discuss	the basics of various Power train sensors and a	associated syste	ms	for p	prop	er		
	dynamics and stability in Automotive systems.							
	hend various sensors for vehicle body manage			vario	ous	sens	ors	
	nologies for passenger convenience, safety and							
	t various communication standards and protoco	ols followed wit	hin	the	auto	omot	ive	
systems								
Course Outcor	ne							
1. Identify	and understand the basic automotive parts an	nd the requirem	ent	of s	sense	ors a	and	
	egration in different automotive systems.							
	and identify the basics of various Power train set							
	hend and analyse various systems like ABS,	ESP, TCS, etc	for	un	ders	tand	ing	
	dynamics and stability.				0		•,	
	hend the various sensors for vehicle body ma	nagement, conv	enie	ence	å s	secu	rity	
systems 5 Identify	various technologies developed for passenger	convenience A	ir B	20.0	lenl	ovm	ont	
•	t Belt Tensioner System, etc with the students	convenience, A	п р	ag (lepi	Oym	CIII	
	ze various communication standards and protoc	ols followed wit	thin	the	auto	omot	ive	
systems	-							
•	and create analytical designing of novel protot	ype models for	vari	ous	auto	omot	ive	
electron	ic systems.							
Module:1 In	traduction to Automotive Engineering				,	1 ha		
	troduction to Automotive Engineering, itomotive Management systems				4	4 ho	urs	
	ombustion Engines, Transmission, Differential	Gear Braking Sy	vstei	ms				
	Modern Automotive Systems and need for				oiles			
	as of electronics in the automobiles, Possibilitie						ive	
	ng technologies and Industry trends.	U						
	wer train Sensors					4 ho		
	ust temperature sensor, NOx sensor, PM sensor	· · ·	ensc	or, le	evel	sens	sor,	
torque sensor, s	peed sensor, mass flow sensor, manifold pressu	re sensor.						
Module:3 Se	nsors for Chassis management				/	4 ho	lire	
	ensors/direction sensors, steering position sensor	or (multi turn)	2006	lera				
	ement), brake pneumatic pressure sensor, ABS s							
Module:4 Se	nsors for vehicle body management,					6 ho	11110	
Moune:4 Se	nsors for vehicle body management,					9 HQ	u1 5	

	Sensors for automotive vehicle convenience and security systems		
sensors. T parking gu and health	rs (CO ₂), Temperature/humidity sensor, air bag sen ire pressure monitoring systems, Two wheeler ar tide systems, anti-lock braking system, future safety in monitoring, Safety and Reliability, Traction Co	nd Four whee y technologies ontrol, Vehic	ler security systems, s, Vehicle diagnostics le dynamics control,
	rs and tilt sensors for sensing skidding and anti-cosonic Doppler sensors.	collision, Anti	-collision techniques
Module:5	Air Bag and Seat Belt Pre tensioner Systems		3 hours
	Sensor Functions, Distributed Front Air Bag sens ide-Impact Sensing, and Future Occupant Protection		Single-Point Sensing
Module·6	Passenger Convenience Systems		3 hours
Electromed	chanical Seat, Seat Belt Height, Steering Wheel, ystems, Tire Pressure Control Systems, Electromecha		Adjustments, Central
Module:7	Modern Trends and Technical Solutions		4 hours
•	ms:- Terminology and concepts, Why by-wire, FLI lity, Drive-by-wire case studies- prototype develop	· •	
•	lity, Drive-by-wire case studies- prototype develops ation.	· •	
dependabil communica	lity, Drive-by-wire case studies- prototype develops ation.	· •	f In vehicle
dependabil communica Module:8 Text Book	lity, Drive-by-wire case studies- prototype develops ation. Contemporary Issues Total ((s))	ment-future of	f In vehicle 2 hours 30 hours
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Ap	proved by Academic Council	No. 55	Date	13-06-2019
	commended by Board of Studies	26-04-2019		
Mo	ode of Evaluation: Continuous Assessment	nt and FAT		
	<u> </u>	Tota	al Laboratory H	Iours 30 hours
	velocity (direction and speed of movem			
	(magnetometers), to continuously calcu	1 / ·	U	
5	(accelerometers), rotation sensors (gy	•	0	
5	bones, occupied surface, profile structu Develop an intelligent inertial navigat		<u>.</u>	nsors 6 hours
	classification system which can classified surface profile structure			n hip
	or a child's safety seat is fitted).	-	-	-
	occupants (for instance, if a child is sit	0		
	prevented when deployment would be			
4	In certain situations, airbag triggering i			
	principle, develop an anti-collision syst			
	improve the passenger safety. Using the		•	ction
3	Anti-collision system is preferred for a			6 hours
	temperature in a non-contact method w			Sinc
4	develop a suitable system which can			
2	to the vehicle to conserve power and in After studying the characteristics of	-		sors. 6 hours
	indication. Develop a better way of set	neels		
	communication with the sensors re			
	resulted in unreliable communication			
	signal is minimized in order to conser	ve power. Unf	fortunately, this	s has

Course Code	Course Title		L	Г	P J	C			
ECE6090	Fiber optic Sensors and Photonics				0 0	3			
Prerequisite	ECE5060 Principles of Sensors and Signal Conditi	oning	Sylla	bu	s Vers	sion			
			1.0						
Course Objectives									
1. To introduce the	he theory and technology of fiber optics sensing to i	mprove thei	r und	ers	tandin	ıg in			
rapidly growin	g field.								
-	optical parameters in optical devices to understand	the phenome	ena in	du	ced du	e to			
intensity based									
	ne phase, charge distribution due to polarization	effects and	its a	ppl	icatio	n 1n			
optical sensing		volved for (liffor	ont	nolur	nora			
-	nd decide the process flow conditions and steps in te optical characteristic for polymer waveguides bas		inter	ent	polyl	ners			
	te optical characteristic for polymer waveguides bas	eu sensing.							
Course Outcomes									
	basic knowledge of optical waveguides and optical	l devices en	nploy	ed	in op	tical			
sensors.					-				
	sance in optical parameters involved in active and p	-							
	naracteristics of a suitable optical materials for th	ne sensing o	device	e i	n a g	iven			
application.					cc	1			
• •	pply the knowledge in designing interferometric dev	ices which i	s moi	re e	errecti	vely			
used in sensing	e of different polymers and their chemical, optica	al characteri	etice	to	form	ilate			
miniaturized o			sucs	10	IOIIII	iiate			
	F								
	Theory of Optical Waveguides	01.1	• 1	D		ours			
	ical waveguides, formation of guided modes,								
_	n fields from waveguide, Effective index metho Basic characteristic of Optical Fiber Waveguides,								
1 1 0	ectromagnetic Modes in Cylindrical Waveguides.	Acceptance	angi	С,	INUITIC	iicai			
Module:2	Active and Passive Optical Components				7 h	ours			
-	ousto optic wave guide devices, directional couple	-			-				
	filtersetc, Yjunction, powersplitters, arrayed waveguid	ledevices,fib	erpig	tai	ling, e	nd-			
fiber prism coupling, l	FBG and fabrication of FBG, Tapered couplers.								
Module:3	Intensity and Polarization Sensors				7 h	ours			
I	smissive concept –Reflective concept-Micro bend	ing concept	Tran	em					
•	optic effect-Interferometers –Mach Zehnder-Miche								
	detection-Polarization maintaining fibers. Displace	•			0				
	ending Technology- Applications of displacement a								
	Interferometric Sensors					ours			
	nsmissive concepts, Microbending –Intrinsic conc ensors: Turbine flowmeters- Differential pressure								
a martine di sur di sur	angara Turbing Howmatary Differential programs	tlowgongor	•c	000	r Dor	nler			

velocity sensors-Applications- Sagnac Interferometer for rotation sensing. Magnetic and electric field sensors: Intensity and phase modulation types– applications.

Module:5		Polymer based waveguid	le in sensing			7 hours
Polymer ba	used wave	guide, materials, properties	s, fabrication proces	ss of polyr	ner based	ł waveguide,
Polymer ba	sed optication	al components - Passive, A	ctive polymer devic	ces, Ring l	Resonator	r, structure, theory,
Filter using	Ring Res	sonator-application in sensi	ing			•
Module:6		Fiber based Chemical Se	enors			5 hours
		ical Sensing : Absorp	tion, Fluorescence	, Chemi-	luminesc	ence, Vibrational
Spectrosco	pic, SPR.					
Module:7		Fiber based Bio-Senors				3 hours
	l Bio mo	lecules sensing: High Inc	lev CDD Hollow	core fibe	r probas	
molecules.	1 DIO-1110	iecules sensing. Then hic	iex, SFK, Hollow	core moe	i probes,	, Laber Free Dio-
molecules.						
Module:8						2 hours
						_ 100015
			Total Lecture hou	urs: 45 h	nours	
Text Book	(s):					
1.	< ,	A. Krohn, Trevor W. M	MacDougall. Alexi	s Mende	z. "Fibe	r Optic Sensors:
		nentals and Applications" S				
2.	Eric Ud	ld , William B. Spillman J	Ir., "Fiber Optic Se	nsors: An	Introduc	ction for Engineers
		entists", Wiley, 2nd Ed., 20)11. ISBN: 0470126	5841		-
Reference	Book(s)					
1.		ang & et. al., "Fundamenta	als of Optical Fiber	Sensors"	Wiley, 1	st Ed., 2012.ISBN:
	047057					
2		Yin, Paul B. Ruffin, and	Francis T.S. Yu, "F	iber Optic	Sensors	",CRC Press, 2 Ed,
_		SIN: B078JN75QW		~ ~ .	~ .	
3		ni&et.al.,"Optical Chemica			e Series	II: Mathematics,
M 1 CT	•	and Chemistry, Springer, 2			T	
wode of Ev	valuation:	CAT, Digital Assignments	, Quiz, Online cours	se and FA	1	
Recom	mended	by Board of Studies	26/04/2019			
		cademic Council	No. 55	Dete	13/06/2	010
Approv	veu by Ac		110.33	Date	13/00/2	019